

# SN74AVC4T774 4-Bit Dual-Supply Bus Transceiver With Configurable Voltage-Level Shifting and 3-State Outputs With Independent Direction Control Inputs

## 1 Features

- Each channel has an independent DIR control input
- Control inputs  $V_{IH}/V_{IL}$  levels are referenced to  $V_{CCA}$  voltage
- Fully configurable dual-rail design allows each port to operate over the full 1.1V to 3.6V power-supply range
- I/Os are 4.6V tolerant
- $I_{off}$  Supports partial power-down-mode operation
- Typical data rates
  - 380Mbps (1.8V to 3.3V translation)
  - 200Mbps (<1.8V to 3.3V translation)
  - 200Mbps (translate to 2.5V or 1.8V)
  - 150Mbps (translate to 1.5V)
  - 100Mbps (translate to 1.2V)
- Latch-up performance exceeds 100mA Per JESD 78, class II
- ESD Protection exceeds the following levels (tested per JESD 22)
  - $\pm 8000V$  Human-body model (A114-A)
  - 250V Machine model (A115-A)
  - $\pm 1500V$  Charged-device model (C101)

## 2 Applications

- [Personal electronic](#)
- [Industrial](#)
- [Enterprise](#)
- [Telecom](#)

## 3 Description

This 4-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.1V to 3.6V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.1 to 3.6V. The SN74AVC4T774 is optimized to operate with  $V_{CCA}/V_{CCB}$  set at 1.4V to 3.6V. It is operational with  $V_{CCA}/V_{CCB}$  as low as 1.2V. This allows for universal low-voltage bi-directional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, and 3.3V voltage nodes.

The SN74AVC4T774 is designed for asynchronous communication between data buses. The logic levels

of the direction-control (DIR) input and the output-enable ( $\overline{OE}$ ) input activate either the B-port outputs or the A-port outputs or place both output ports in the high-impedance mode. The device transmits data from the A bus to the B bus when the B outputs are activated, and from the B bus to the A bus when the A outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess  $I_{CC}$  and  $I_{CCZ}$ .

The SN74AVC4T774 is designed so that the control pins (DIR1, DIR2, DIR3, DIR4, and  $\overline{OE}$ ) are supplied by  $V_{CCA}$ . This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, then both ports are in the high-impedance state.

For a high-impedance state during power-up or power-down,  $\overline{OE}$  should be tied to  $V_{CCA}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. Since this device has CMOS inputs, it is very important to not allow them to float. If the inputs are not driven to either a high  $V_{CC}$  state, or a low-GND state, an undesirable larger than expected  $I_{CC}$  current may result. Since the input voltage settlement is governed by many factors (for example, capacitance, board-layout, package inductance, surrounding conditions, and so forth), ensuring that they these inputs are kept out of erroneous switching states and tying them to either a high or a low level minimizes the leakage-current.

### Package Information

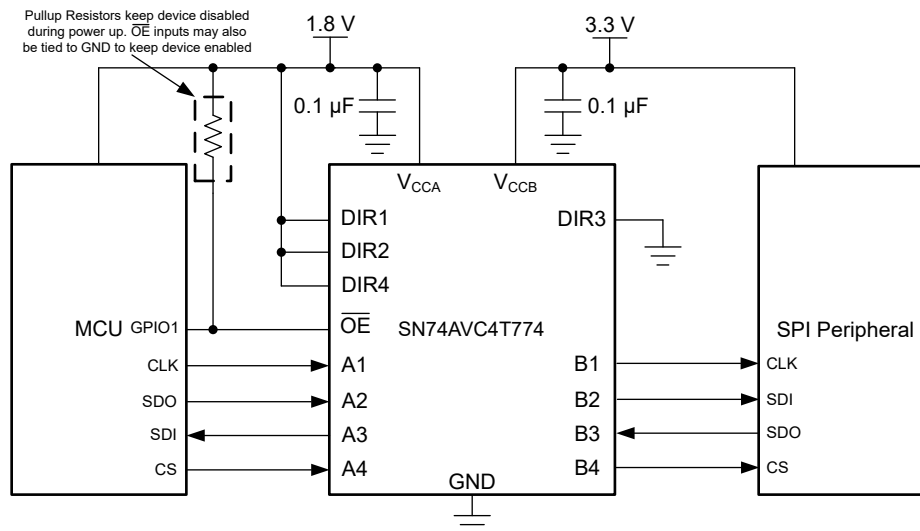
| PART NUMBER  | PACKAGE <sup>(1)</sup> | PACKAGE SIZE <sup>(2)</sup> |
|--------------|------------------------|-----------------------------|
| SN74AVC4T774 | PW (TSSOP, 16)         | 5mm × 6.4mm                 |
|              | RGY (VQFN, 16)         | 4mm × 3.5mm                 |
|              | RSV (UQFN, 16)         | 2.6mm × 1.8mm               |
|              | BQB (WQFN, 16)         | 3.5mm × 2.5mm               |
|              | DYY (SOT, 16)          | 4.2mm × 2mm                 |

(1) For more information, [Section 11](#).

(2) The package size (length × width) is a nominal value and includes pins, where applicable.



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

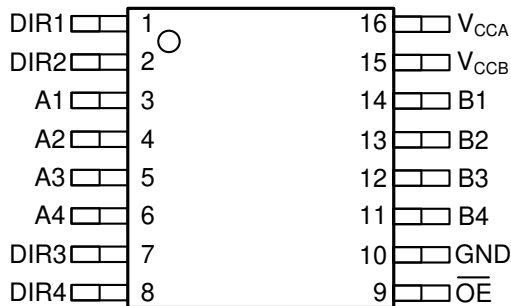


**Typical Application Schematic**

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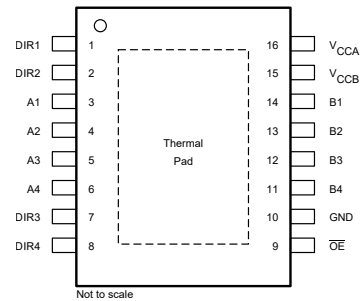
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## 4 Pin Configuration and Functions

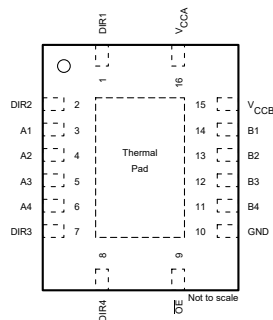


A. Shown for a single channel

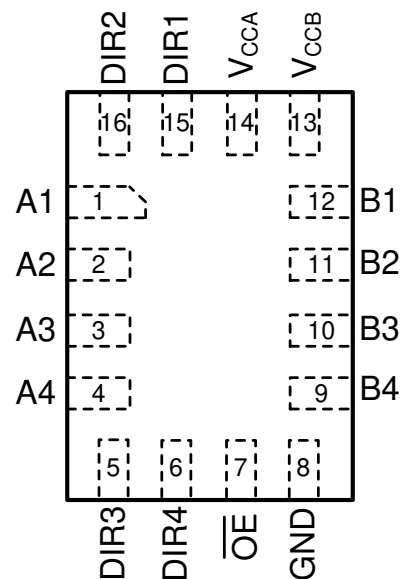
**Figure 4-1. PW Package, 16-Pin TSSOP (Top View)**



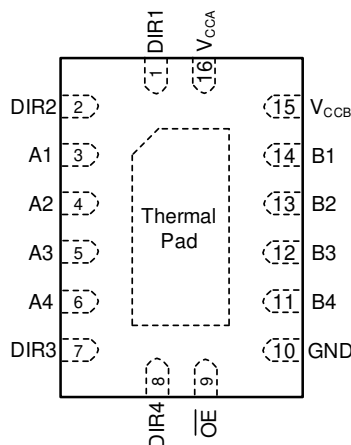
**Figure 4-2. DYY Package, 16-Pin SOT (Top View)**



**Figure 4-3. RGY Package, 16-Pin VQFN (Top View)**



**Figure 4-4. RSV Package, 16-Pin UQFN (Top View)**



**Figure 4-5. BQB Package, 16-Pin WQFN, Transparent (Top View)**

**Table 4-1. Pin Functions**

| PIN             |                     |     | TYPE | DESCRIPTION                                                                                                            |
|-----------------|---------------------|-----|------|------------------------------------------------------------------------------------------------------------------------|
| NAME            | PW, RGY<br>BQB, DYY | RSV |      |                                                                                                                        |
| DIR1            | 1                   | 15  | I    | Direction-control input referenced to $V_{CCA}$ , controls signal flow for the first (A1/B1) I/O channels.             |
| DIR2            | 2                   | 16  | I    | Direction-control input referenced to $V_{CCA}$ , controls signal flow for the second (A2/B2) I/O channels.            |
| A1              | 3                   | 1   | I/O  | Input/output A1. Referenced to $V_{CCA}$ .                                                                             |
| A2              | 4                   | 2   | I/O  | Input/output A2. Referenced to $V_{CCA}$ .                                                                             |
| A3              | 5                   | 3   | I/O  | Input/output A3. Referenced to $V_{CCA}$ .                                                                             |
| A4              | 6                   | 4   | I/O  | Input/output A4. Referenced to $V_{CCA}$ .                                                                             |
| DIR3            | 7                   | 5   | I    | Direction-control input referenced to $V_{CCA}$ , controls signal flow for the third (A3/B3) I/O channels.             |
| DIR4            | 8                   | 6   | I    | Direction-control input referenced to $V_{CCA}$ , controls signal flow for the fourth (A4/B4) I/O channels.            |
| $\overline{OE}$ | 9                   | 7   | I    | 3-state output-mode enables. Pull $\overline{OE}$ high to place all outputs in 3-state mode. Referenced to $V_{CCA}$ . |
| GND             | 10                  | 8   | —    | Ground.                                                                                                                |
| B4              | 11                  | 9   | I/O  | Input/output B4. Referenced to $V_{CCB}$ .                                                                             |
| B3              | 12                  | 10  | I/O  | Input/output B3. Referenced to $V_{CCB}$ .                                                                             |
| B2              | 13                  | 11  | I/O  | Input/output B2. Referenced to $V_{CCB}$ .                                                                             |
| B1              | 14                  | 12  | I/O  | Input/output B1. Referenced to $V_{CCB}$ .                                                                             |
| $V_{CCB}$       | 15                  | 13  | —    | B-port supply voltage. $1.1V \leq V_{CCB} \leq 3.6V$ .                                                                 |
| $V_{CCA}$       | 16                  | 14  | —    | A-port supply voltage. $1.1V \leq V_{CCA} \leq 3.6V$ .                                                                 |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                      |                                                                                             |                    | MIN  | MAX                    | UNIT |
|--------------------------------------|---------------------------------------------------------------------------------------------|--------------------|------|------------------------|------|
| V <sub>CCA</sub><br>V <sub>CCB</sub> | Supply voltage                                                                              |                    | −0.5 | 4.6                    | V    |
| V <sub>I</sub>                       | Input voltage range <sup>(2)</sup>                                                          | I/O ports (A port) | −0.5 | 4.6                    | V    |
|                                      |                                                                                             | I/O ports (B port) | −0.5 | 4.6                    |      |
|                                      |                                                                                             | Control inputs     | −0.5 | 4.6                    |      |
| V <sub>O</sub>                       | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | A port             | −0.5 | 4.6                    | V    |
|                                      |                                                                                             | B port             | −0.5 | 4.6                    |      |
| V <sub>O</sub>                       | Voltage range applied to any output in the high or low state <sup>(2)</sup><br>(3)          | A port             | −0.5 | V <sub>CCA</sub> + 0.5 | V    |
|                                      |                                                                                             | B port             | −0.5 | V <sub>CCB</sub> + 0.5 |      |
| I <sub>IK</sub>                      | Input clamp current                                                                         | V <sub>I</sub> < 0 |      | −50                    | mA   |
| I <sub>OK</sub>                      | Output clamp current                                                                        | V <sub>O</sub> < 0 |      | −50                    | mA   |
| I <sub>O</sub>                       | Continuous output current                                                                   |                    |      | ±50                    | mA   |
|                                      | Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND                     |                    |      | ±100                   | mA   |
| T <sub>J</sub>                       | Junction temperature                                                                        |                    |      | 150                    | °C   |
| T <sub>stg</sub>                     | Storage temperature                                                                         |                    | −65  | 150                    | °C   |

(1) Stresses beyond those listed under [Absolute Maximum Ratings](#) may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under [Recommended Operating Conditions](#) is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 4.6V maximum if the output current rating is observed.

### 5.2 ESD Ratings

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±8000 | V    |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |
|                    |                         | Machine model (A115-A)                                                         | 250   |      |

(1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1) (2) (3)</sup>

|                  |                          |                                                                                                       | V <sub>CCI</sub> | V <sub>CCO</sub> | MIN                     | MAX | UNIT |
|------------------|--------------------------|-------------------------------------------------------------------------------------------------------|------------------|------------------|-------------------------|-----|------|
| V <sub>CCA</sub> | Supply voltage           |                                                                                                       |                  |                  | 1.1                     | 3.6 | V    |
| V <sub>CCB</sub> | Supply voltage           |                                                                                                       |                  |                  | 1.1                     | 3.6 | V    |
| V <sub>IH</sub>  | High-level input voltage | Data inputs <sup>(4)</sup>                                                                            | 1.1V to 1.95V    |                  | V <sub>CCI</sub> × 0.65 |     | V    |
|                  |                          |                                                                                                       | 1.95V to 2.7V    |                  | 1.6                     |     |      |
|                  |                          |                                                                                                       | 2.7V to 3.6V     |                  | 2                       |     |      |
| V <sub>IL</sub>  | Low-level input voltage  | Data inputs <sup>(4)</sup>                                                                            | 1.1V to 1.95V    |                  | V <sub>CCI</sub> × 0.35 |     | V    |
|                  |                          |                                                                                                       | 1.95V to 2.7V    |                  |                         | 0.7 |      |
|                  |                          |                                                                                                       | 2.7V to 3.6V     |                  |                         | 0.8 |      |
| V <sub>IH</sub>  | High-level input voltage | Control Inputs<br>(referenced to V <sub>CCA</sub> )<br><sup>(5)</sup> (DIRx, $\overline{\text{OE}}$ ) | 1.1V to 1.95V    |                  | V <sub>CCA</sub> × 0.65 |     | V    |
|                  |                          |                                                                                                       | 1.95V to 2.7V    |                  | 1.6                     |     |      |
|                  |                          |                                                                                                       | 2.7V to 3.6V     |                  | 2                       |     |      |

### 5.3 Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)<sup>(1) (2) (3)</sup>

|                 |                                    |                                                                                                   | V <sub>CCI</sub> | V <sub>CCO</sub> | MIN                     | MAX              | UNIT |
|-----------------|------------------------------------|---------------------------------------------------------------------------------------------------|------------------|------------------|-------------------------|------------------|------|
| V <sub>IL</sub> | Low-level input voltage            | Control Inputs<br>(referenced to V <sub>CCA</sub> )<br>( <sup>(5)</sup> (DIRx, $\overline{OE}$ )) | 1.1V to 1.95V    |                  | V <sub>CCA</sub> × 0.35 |                  | V    |
|                 |                                    |                                                                                                   | 1.95V to 2.7V    |                  | 0.7                     |                  |      |
|                 |                                    |                                                                                                   | 2.7V to 3.6V     |                  | 0.8                     |                  |      |
| V <sub>I</sub>  | Input voltage                      |                                                                                                   |                  |                  | 0                       | 3.6              | V    |
| V <sub>O</sub>  | Output voltage                     | Active state                                                                                      |                  |                  | 0                       | V <sub>CCO</sub> | V    |
|                 |                                    | 3-state                                                                                           |                  |                  | 0                       | 3.6              |      |
| I <sub>OH</sub> | High-level output current          |                                                                                                   |                  | 1.1V to 1.3V     | −3                      |                  | mA   |
|                 |                                    |                                                                                                   |                  | 1.4V to 1.6V     | −6                      |                  |      |
|                 |                                    |                                                                                                   |                  | 1.65V to 1.95V   | −8                      |                  |      |
|                 |                                    |                                                                                                   |                  | 2.3V to 2.7V     | −9                      |                  |      |
|                 |                                    |                                                                                                   |                  | 3V to 3.6V       | −12                     |                  |      |
| I <sub>OL</sub> | Low-level output current           |                                                                                                   |                  | 1.1V to 1.3V     | 3                       |                  | mA   |
|                 |                                    |                                                                                                   |                  | 1.4V to 1.6V     | 6                       |                  |      |
|                 |                                    |                                                                                                   |                  | 1.65V to 1.95V   | 8                       |                  |      |
|                 |                                    |                                                                                                   |                  | 2.3V to 2.7V     | 9                       |                  |      |
|                 |                                    |                                                                                                   |                  | 3V to 3.6V       | 12                      |                  |      |
| Δt/Δv           | Input transition rise or fall rate |                                                                                                   |                  |                  | 5                       |                  | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     |                                                                                                   |                  |                  | −40                     | 85               | °C   |

- (1) V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.  
(2) V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.  
(3) All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the [Implications of Slow or Floating CMOS Inputs](#) application report.  
(4) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCI</sub> × 0.7V, V<sub>IL</sub> max = V<sub>CCI</sub> × 0.3V  
(5) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCA</sub> × 0.7V, V<sub>IL</sub> max = V<sub>CCA</sub> × 0.3V

### 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | SN74AVC4T774 |            |           |            |            | UNIT |
|-------------------------------|----------------------------------------------|--------------|------------|-----------|------------|------------|------|
|                               |                                              | RGY (VQFN)   | RSV (UQFN) | DYY (SOT) | BQB (WQFN) | PW (TSSOP) |      |
|                               |                                              | 16 PINS      | 16 PINS    | 16 PINS   | 16 PINS    | 16 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 68.8         | 139.2      | 163.4     | 79.1       | 102.8      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 70.6         | 64.9       | 90.0      | 77.5       | 35.9       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 45           | 67.7       | 93.1      | 49.0       | 57.5       | °C/W |
| Y <sub>JT</sub>               | Junction-to-top characterization parameter   | 11.9         | 1.7        | 10.9      | 7.3        | 1.6        | °C/W |
| Y <sub>JB</sub>               | Junction-to-board characterization parameter | 44.7         | 67.4       | 92.1      | 48.9       | 56.9       | °C/W |
| R <sub>θJC(bottom)</sub>      | Junction-to-case (bottom) thermal resistance | 28.2         | N/A        | N/A       | 26.4       | N/A        | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 5.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)<sup>(1) (2) (3)</sup>

| PARAMETER           | TEST CONDITIONS | $V_{CCA}$                                                                | $V_{CCB}$      | TA = 25°C    |              |             | –40°C to 85°C   |     |         | UNIT    |
|---------------------|-----------------|--------------------------------------------------------------------------|----------------|--------------|--------------|-------------|-----------------|-----|---------|---------|
|                     |                 |                                                                          |                | MIN          | TYP          | MAX         | MIN             | TYP | MAX     |         |
| $V_{OH}$            |                 | $I_{OH} = -100\mu A$                                                     | $V_I = V_{IH}$ | 1.1V to 3.6V | 1.1V to 3.6V |             | $V_{CCO} - 0.2$ |     |         | V       |
|                     |                 |                                                                          |                | 1.2V         | 1.2V         | 0.95        |                 |     |         |         |
|                     |                 |                                                                          |                | 1.4V         | 1.4V         |             | 1.05            |     |         |         |
|                     |                 |                                                                          |                | 1.65V        | 1.65V        |             | 1.2             |     |         |         |
|                     |                 |                                                                          |                | 2.3V         | 2.3V         |             | 1.75            |     |         |         |
|                     |                 |                                                                          |                | 3V           | 3V           |             | 2.3             |     |         |         |
| $V_{OL}$            |                 | $I_{OL} = 100\mu A$                                                      | $V_I = V_{IL}$ | 1.1V to 3.6V | 1.1V to 3.6V |             |                 |     | 0.2     | V       |
|                     |                 |                                                                          |                | 1.2V         | 1.2V         | 0.25        |                 |     |         |         |
|                     |                 |                                                                          |                | 1.4V         | 1.4V         |             |                 |     | 0.35    |         |
|                     |                 |                                                                          |                | 1.65V        | 1.65V        |             |                 |     | 0.45    |         |
|                     |                 |                                                                          |                | 2.3V         | 2.3V         |             |                 |     | 0.55    |         |
|                     |                 |                                                                          |                | 3V           | 3V           |             |                 |     | 0.7     |         |
| $I_I$               | Control inputs  | $V_I = V_{CCA}$ or GND                                                   |                | 1.1V to 3.6V | 1.1V to 3.6V | $\pm 0.025$ | $\pm 0.25$      |     | $\pm 1$ | $\mu A$ |
| $I_{off}$           | A or B port     | $V_I$ or $V_O = 0$ to 3.6V                                               |                | 0V           | 0V to 3.6V   | $\pm 0.1$   | $\pm 1$         |     | $\pm 5$ | $\mu A$ |
|                     |                 |                                                                          |                | 0V to 3.6V   | 0V           | $\pm 0.1$   | $\pm 1$         |     | $\pm 5$ |         |
| $I_{OZ}$            | A or B port     | $V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND, $\overline{OE} = V_{IH}$ |                | 3.6V         | 3.6V         | $\pm 0.5$   | $\pm 2.5$       |     | $\pm 5$ | $\mu A$ |
| $I_{CCA}$           |                 | $V_I = V_{CCI}$ or GND, $I_O = 0$                                        |                | 1.1V to 3.6V | 1.1V to 3.6V |             |                 |     | 8       | $\mu A$ |
|                     |                 |                                                                          |                | 0V           | 0V to 3.6V   |             | –2              |     |         |         |
|                     |                 |                                                                          |                | 0V to 3.6V   | 0V           |             |                 |     | 8       |         |
| $I_{CCB}$           |                 | $V_I = V_{CCI}$ or GND, $I_O = 0$                                        |                | 1.1V to 3.6V | 1.1V to 3.6V |             |                 |     | 8       | $\mu A$ |
|                     |                 |                                                                          |                | 0V           | 0V to 3.6V   |             |                 |     | 8       |         |
|                     |                 |                                                                          |                | 0V to 3.6V   | 0V           |             | –2              |     |         |         |
| $I_{CCA} + I_{CCB}$ |                 | $V_I = V_{CCI}$ or GND, $I_O = 0$                                        |                | 1.1V to 3.6V | 1.1V to 3.6V |             |                 |     | 16      | $\mu A$ |
| $C_i$               | Control inputs  | $V_I = 3.3V$ or GND                                                      |                | 3.3V         | 3.3V         | 2.5         |                 |     | 4.5     | pF      |
| $C_{io}$            | A or B port     | $V_O = 3.3V$ or GND                                                      |                | 3.3V         | 3.3V         | 5           |                 |     | 7       | pF      |

(1)  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.

(2)  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

(3) All unused data inputs of the device must be held at  $V_{CCI}$  or GND to ensure proper device operation. Refer to the [Implications of Slow or Floating CMOS Inputs](#) application report.

## 5.6 Switching Characteristics: $V_{CCA} = 1.2V \pm 0.1V$

See [Figure 8-1](#) and [Table 8-1](#) for test circuit and loading. See [Figure 8-2](#), [Figure 8-3](#), and [Figure 8-4](#) for measurement waveforms.

| PARAMET<br>ER    | PARAMET<br>ER    | FROM | TO | Test<br>Conditions | V <sub>CCB</sub> =<br>1.2V ± 0.1V |     | V <sub>CCB</sub> =<br>1.5V ± 0.1V |     | V <sub>CCB</sub> =<br>1.8V ±<br>0.15V |     | V <sub>CCB</sub> =<br>2.5V ± 0.2V |     | V <sub>CCB</sub> =<br>3.3V ± 0.3V |     | UNIT |
|------------------|------------------|------|----|--------------------|-----------------------------------|-----|-----------------------------------|-----|---------------------------------------|-----|-----------------------------------|-----|-----------------------------------|-----|------|
|                  |                  |      |    |                    | MIN                               | MAX | MIN                               | MAX | MIN                                   | MAX | MIN                               | MAX | MIN                               | MAX |      |
| t <sub>PLH</sub> | t <sub>PLH</sub> | A    | B  | -40°C to<br>85°C   | 2                                 | 7.5 | 1.5                               | 5.5 | 1                                     | 4.5 | 1                                 | 4   | 0.5                               | 4   | ns   |
| t <sub>PHL</sub> | t <sub>PHL</sub> |      |    |                    | 1.5                               | 5.5 | 1                                 | 4   | 1                                     | 4   | 0.5                               | 4.5 | 0.5                               | 6   |      |
| t <sub>PLH</sub> | t <sub>PLH</sub> | B    | A  |                    | 2                                 | 7   | 1.5                               | 6.5 | 1                                     | 6   | 1                                 | 6   | 1                                 | 6   |      |
| t <sub>PHL</sub> | t <sub>PHL</sub> |      |    |                    | 1.5                               | 5.5 | 1                                 | 5   | 1                                     | 4.5 | 0.5                               | 4   | 0.5                               | 4   |      |
| t <sub>PZH</sub> | t <sub>PZH</sub> | OE   | A  |                    | 2.5                               | 8   | 2                                 | 8   | 1                                     | 8   | 1                                 | 8   | 1                                 | 8.5 |      |
| t <sub>PZL</sub> | t <sub>PZL</sub> |      |    |                    | 2.5                               | 9   | 2                                 | 9   | 1.5                                   | 9   | 1                                 | 9   | 1                                 | 9   |      |
| t <sub>PZH</sub> | t <sub>PZH</sub> | OE   | B  |                    | 2                                 | 7.5 | 1.5                               | 5.5 | 1                                     | 6.5 | 1                                 | 9.5 | 0.5                               | 30  |      |
| t <sub>PZL</sub> | t <sub>PZL</sub> |      |    |                    | 2.5                               | 8.5 | 1.5                               | 6.5 | 1                                     | 7   | 1                                 | 8.5 | 0.5                               | 24  |      |
| t <sub>PHZ</sub> | t <sub>PHZ</sub> | OE   | A  |                    | 3                                 | 6.5 | 2                                 | 6.5 | 2                                     | 6.5 | 1.5                               | 6.5 | 2                                 | 6.5 |      |
| t <sub>PLZ</sub> | t <sub>PLZ</sub> |      |    |                    | 3                                 | 6.5 | 2.5                               | 6.5 | 2.5                                   | 6.5 | 2                                 | 6.5 | 2                                 | 6.5 |      |
| t <sub>PHZ</sub> | t <sub>PHZ</sub> | OE   | B  |                    | 3                                 | 6   | 2.5                               | 5.5 | 2                                     | 6   | 1.5                               | 5   | 2                                 | 6.5 |      |
| t <sub>PLZ</sub> | t <sub>PLZ</sub> |      |    |                    | 3                                 | 6   | 2.5                               | 5.5 | 2.5                                   | 5.5 | 1.5                               | 5   | 2                                 | 6   |      |

## 5.7 Switching Characteristics: $V_{CCA} = 1.5V \pm 0.1V$

See [Figure 8-1](#) and [Table 8-1](#) for test circuit and loading. See [Figure 8-2](#), [Figure 8-3](#), and [Figure 8-4](#) for measurement waveforms.

| PARAMETER | PARAMETER | FROM            | TO | $V_{CCB} = 1.2V \pm 0.1V$ |     | $V_{CCB} = 1.5V \pm 0.1V$ |      | $V_{CCB} = 1.8V \pm 0.15V$ |      | $V_{CCB} = 2.5V \pm 0.2V$ |      | $V_{CCB} = 3.3V \pm 0.3V$ |      | UNIT |
|-----------|-----------|-----------------|----|---------------------------|-----|---------------------------|------|----------------------------|------|---------------------------|------|---------------------------|------|------|
|           |           |                 |    | MIN                       | MAX | MIN                       | MAX  | MIN                        | MAX  | MIN                       | MAX  | MIN                       | MAX  |      |
| $t_{PLH}$ | $t_{PLH}$ | A               | B  | 1.5                       | 6.5 | 0.3                       | 6.3  | 0.3                        | 5.2  | 0.4                       | 4.2  | 0.4                       | 4.2  | ns   |
| $t_{PHL}$ | $t_{PHL}$ |                 |    | 1.5                       | 4.5 | 0.3                       | 6.3  | 0.3                        | 5.2  | 0.4                       | 4.2  | 0.4                       | 4.2  |      |
| $t_{PLH}$ | $t_{PLH}$ | B               | A  | 1.5                       | 5   | 0.7                       | 6.3  | 0.5                        | 6    | 0.4                       | 5.7  | 0.3                       | 5.6  | ns   |
| $t_{PHL}$ | $t_{PHL}$ |                 |    | 1.5                       | 4   | 0.7                       | 6.3  | 0.5                        | 6    | 0.4                       | 5.7  | 0.3                       | 5.6  |      |
| $t_{PZH}$ | $t_{PZH}$ | $\overline{OE}$ | A  | 1.5                       | 5   | 1.4                       | 9.6  | 1.1                        | 9.5  | 0.7                       | 9.4  | 0.4                       | 9.4  | ns   |
| $t_{PZL}$ | $t_{PZL}$ |                 |    | 2                         | 5.5 | 1.4                       | 9.6  | 1.1                        | 9.5  | 0.7                       | 9.4  | 0.4                       | 9.4  |      |
| $t_{PZH}$ | $t_{PZH}$ | $\overline{OE}$ | B  | 2                         | 6.5 | 1.4                       | 9.6  | 1.1                        | 7.7  | 0.9                       | 5.8  | 0.9                       | 5.6  | ns   |
| $t_{PZL}$ | $t_{PZL}$ |                 |    | 2                         | 7.5 | 1.4                       | 9.6  | 1.1                        | 7.7  | 0.9                       | 5.8  | 0.9                       | 5.6  |      |
| $t_{PHZ}$ | $t_{PHZ}$ | $\overline{OE}$ | A  | 2                         | 5   | 1.8                       | 10.2 | 1.5                        | 10.2 | 1.3                       | 10.2 | 1.6                       | 10.2 | ns   |
| $t_{PLZ}$ | $t_{PLZ}$ |                 |    | 2.5                       | 4.5 | 1.8                       | 10.2 | 1.5                        | 10.2 | 1.3                       | 10.2 | 1.6                       | 10.2 |      |
| $t_{PHZ}$ | $t_{PHZ}$ | $\overline{OE}$ | B  | 3                         | 5.5 | 1.9                       | 10.3 | 1.9                        | 9.1  | 1.4                       | 7.4  | 1.2                       | 7.6  | ns   |
| $t_{PLZ}$ | $t_{PLZ}$ |                 |    | 3                         | 5.5 | 1.9                       | 10.3 | 1.9                        | 9.1  | 1.4                       | 7.4  | 1.2                       | 7.6  |      |

## 5.8 Switching Characteristics: $V_{CCA} = 1.8V \pm 0.15V$

See Figure 8-1 and Table 8-1 for test circuit and loading. See Figure 8-2, Figure 8-3, and Figure 8-4 for measurement waveforms.

| PARAMET<br>ER    | PARAMET<br>ER    | FROM | TO | Test<br>Conditions | V <sub>CCB</sub> =<br>1.2V ± 0.1V |     | V <sub>CCB</sub> =<br>1.5V ± 0.1V |      | V <sub>CCB</sub> =<br>1.8V ±<br>0.15V |      | V <sub>CCB</sub> =<br>2.5V ± 0.2V |      | V <sub>CCB</sub> =<br>3.3V ± 0.3V |      | UNIT |
|------------------|------------------|------|----|--------------------|-----------------------------------|-----|-----------------------------------|------|---------------------------------------|------|-----------------------------------|------|-----------------------------------|------|------|
|                  |                  |      |    |                    | MIN                               | MAX | MIN                               | MAX  | MIN                                   | MAX  | MIN                               | MAX  | MIN                               | MAX  |      |
| t <sub>PLH</sub> | t <sub>PLH</sub> | A    | B  | -40°C to<br>85°C   | 1.5                               | 6.5 | 0.3                               | 6.3  | 0.3                                   | 5.2  | 0.4                               | 4.2  | 0.4                               | 4.2  | ns   |
| t <sub>PHL</sub> | t <sub>PHL</sub> |      |    |                    | 1                                 | 4.5 | 0.3                               | 6.3  | 0.3                                   | 5.2  | 0.4                               | 4.2  | 0.4                               | 4.2  |      |
| t <sub>PLH</sub> | t <sub>PLH</sub> | B    | A  |                    | 1.5                               | 6   | 0.7                               | 6.3  | 0.5                                   | 6    | 0.4                               | 5.7  | 0.3                               | 5.6  |      |
| t <sub>PHL</sub> | t <sub>PHL</sub> |      |    |                    | 1                                 | 4.5 | 0.7                               | 6.3  | 0.5                                   | 6    | 0.4                               | 5.7  | 0.3                               | 5.6  |      |
| t <sub>PZH</sub> | t <sub>PZH</sub> | OE   | A  |                    | 1                                 | 6.5 | 1.4                               | 9.6  | 1.1                                   | 9.5  | 0.7                               | 9.4  | 0.4                               | 9.4  |      |
| t <sub>PZL</sub> | t <sub>PZL</sub> |      |    |                    | 1.5                               | 7.5 | 1.4                               | 9.6  | 1.1                                   | 9.5  | 0.7                               | 9.4  | 0.4                               | 9.4  |      |
| t <sub>PZH</sub> | t <sub>PZH</sub> | OE   | B  |                    | 2                                 | 6   | 1.4                               | 9.6  | 1.1                                   | 7.7  | 0.9                               | 5.8  | 0.9                               | 5.6  |      |
| t <sub>PZL</sub> | t <sub>PZL</sub> |      |    |                    | 2                                 | 7   | 1.4                               | 9.6  | 1.1                                   | 7.7  | 0.9                               | 5.8  | 0.9                               | 5.6  |      |
| t <sub>PHZ</sub> | t <sub>PHZ</sub> | OE   | A  |                    | 2                                 | 6   | 1.8                               | 10.2 | 1.5                                   | 10.2 | 1.3                               | 10.2 | 1.6                               | 10.2 |      |
| t <sub>PLZ</sub> | t <sub>PLZ</sub> |      |    |                    | 2.5                               | 5.5 | 1.8                               | 10.2 | 1.5                                   | 10.2 | 1.3                               | 10.2 | 1.6                               | 10.2 |      |
| t <sub>PHZ</sub> | t <sub>PHZ</sub> | OE   | B  |                    | 2.5                               | 5   | 1.9                               | 10.3 | 1.9                                   | 9.1  | 1.4                               | 7.4  | 1.2                               | 7.6  |      |
| t <sub>PLZ</sub> | t <sub>PLZ</sub> |      |    |                    | 2.5                               | 5   | 1.9                               | 10.3 | 1.9                                   | 9.1  | 1.4                               | 7.4  | 1.2                               | 7.6  |      |

## 5.9 Switching Characteristics: $V_{CCA} = 2.5V \pm 0.2V$

See Figure 8-1 and Table 8-1 for test circuit and loading. See Figure 8-2, Figure 8-3, and Figure 8-4 for measurement waveforms.

| PARAMETER | PARAMETER | FROM            | TO | $V_{CCB} = 1.2V \pm 0.1V$ |     | $V_{CCB} = 1.5V \pm 0.1V$ |     | $V_{CCB} = 1.8V \pm 0.15V$ |     | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | UNIT |
|-----------|-----------|-----------------|----|---------------------------|-----|---------------------------|-----|----------------------------|-----|---------------------------|-----|---------------------------|-----|------|
|           |           |                 |    | MIN                       | MAX | MIN                       | MAX | MIN                        | MAX | MIN                       | MAX | MIN                       | MAX |      |
| $t_{PLH}$ | $t_{PLH}$ | A               | B  | 1.5                       | 6.5 | 0.1                       | 5.7 | 0.1                        | 4.6 | 0.2                       | 3.5 | 0.1                       | 3.6 | ns   |
| $t_{PHL}$ | $t_{PHL}$ |                 |    | 1                         | 4.5 | 0.1                       | 5.7 | 0.1                        | 4.6 | 0.2                       | 3.5 | 0.1                       | 3.6 |      |
| $t_{PLH}$ | $t_{PLH}$ | B               | A  | 1.5                       | 4   | 0.6                       | 4.2 | 0.4                        | 3.9 | 0.2                       | 3.4 | 0.2                       | 3.3 | ns   |
| $t_{PHL}$ | $t_{PHL}$ |                 |    | 1                         | 5   | 0.6                       | 4.2 | 0.4                        | 3.9 | 0.2                       | 3.4 | 0.2                       | 3.3 |      |
| $t_{PZH}$ | $t_{PZH}$ | $\overline{OE}$ | A  | 1                         | 2.5 | 0.7                       | 6.5 | 0.7                        | 5.2 | 0.6                       | 4.8 | 0.4                       | 4.8 | ns   |
| $t_{PZL}$ | $t_{PZL}$ |                 |    | 1                         | 3   | 0.7                       | 6.5 | 0.7                        | 5.2 | 0.6                       | 4.8 | 0.4                       | 4.8 |      |
| $t_{PZH}$ | $t_{PZH}$ | $\overline{OE}$ | B  | 1.5                       | 6   | 0.9                       | 8.8 | 0.8                        | 7   | 0.6                       | 4.8 | 0.6                       | 4   | ns   |
| $t_{PZL}$ | $t_{PZL}$ |                 |    | 2                         | 7   | 0.9                       | 8.8 | 0.8                        | 7   | 0.6                       | 4.8 | 0.6                       | 4   |      |
| $t_{PHZ}$ | $t_{PHZ}$ | $\overline{OE}$ | A  | 1.5                       | 3.5 | 1                         | 8.4 | 1                          | 8.4 | 1                         | 6.2 | 1                         | 6.6 | ns   |
| $t_{PLZ}$ | $t_{PLZ}$ |                 |    | 2                         | 3.5 | 1                         | 8.4 | 1                          | 8.4 | 1                         | 6.2 | 1                         | 6.6 |      |
| $t_{PHZ}$ | $t_{PHZ}$ | $\overline{OE}$ | B  | 2                         | 5   | 1.5                       | 9.4 | 1.3                        | 8.2 | 1.1                       | 6.2 | 0.9                       | 5.2 | ns   |
| $t_{PLZ}$ | $t_{PLZ}$ |                 |    | 2.5                       | 5   | 1.5                       | 9.4 | 1.3                        | 8.2 | 1.1                       | 6.2 | 0.9                       | 5.2 |      |

## 5.10 Switching Characteristics: $V_{CCA} = 3.3V \pm 0.3V$

See [Figure 8-1](#) and [Table 8-1](#) for test circuit and loading. See [Figure 8-2](#), [Figure 8-3](#), and [Figure 8-4](#) for measurement waveforms.

| PARAMETER | PARAMETER | FROM            | TO | $V_{CCB} = 1.2V \pm 0.1V$ |     | $V_{CCB} = 1.5V \pm 0.1V$ |     | $V_{CCB} = 1.8V \pm 0.15V$ |     | $V_{CCB} = 2.5V \pm 0.2V$ |     | $V_{CCB} = 3.3V \pm 0.3V$ |     | UNIT |
|-----------|-----------|-----------------|----|---------------------------|-----|---------------------------|-----|----------------------------|-----|---------------------------|-----|---------------------------|-----|------|
|           |           |                 |    | MIN                       | MAX | MIN                       | MAX | MIN                        | MAX | MIN                       | MAX | MIN                       | MAX |      |
| $t_{PLH}$ | $t_{PLH}$ | A               | B  | 1.5                       | 6   | 0.1                       | 5.6 | 0.1                        | 4.5 | 0.1                       | 3.3 | 0.1                       | 2.9 | ns   |
| $t_{PHL}$ | $t_{PHL}$ |                 |    | 1                         | 4   | 0.1                       | 5.6 | 0.1                        | 4.5 | 0.1                       | 3.3 | 0.1                       | 2.9 |      |
| $t_{PLH}$ | $t_{PLH}$ | B               | A  | 1.5                       | 4   | 0.6                       | 4.2 | 0.4                        | 3.4 | 0.2                       | 3   | 0.1                       | 2.8 | ns   |
| $t_{PHL}$ | $t_{PHL}$ |                 |    | 1.5                       | 7.5 | 0.6                       | 4.2 | 0.4                        | 3.4 | 0.2                       | 3   | 0.1                       | 2.8 |      |
| $t_{PZH}$ | $t_{PZH}$ | $\overline{OE}$ | A  | 1                         | 2.5 | 0.6                       | 8.7 | 0.6                        | 5.2 | 0.6                       | 3.8 | 0.4                       | 3.8 | ns   |
| $t_{PZL}$ | $t_{PZL}$ |                 |    | 1                         | 2.5 | 0.6                       | 8.7 | 0.6                        | 5.2 | 0.6                       | 3.8 | 0.4                       | 3.8 |      |
| $t_{PZH}$ | $t_{PZH}$ | $\overline{OE}$ | B  | 1.5                       | 6   | 0.8                       | 8.7 | 0.6                        | 6.8 | 0.5                       | 4.7 | 0.5                       | 3.8 | ns   |
| $t_{PZL}$ | $t_{PZL}$ |                 |    | 1.5                       | 7   | 0.8                       | 8.7 | 0.6                        | 6.8 | 0.5                       | 4.7 | 0.5                       | 3.8 |      |
| $t_{PHZ}$ | $t_{PHZ}$ | $\overline{OE}$ | A  | 2                         | 4   | 0.7                       | 9.3 | 0.7                        | 8.3 | 0.7                       | 5.6 | 0.7                       | 6.6 | ns   |
| $t_{PLZ}$ | $t_{PLZ}$ |                 |    | 2                         | 4   | 0.7                       | 9.3 | 0.7                        | 8.3 | 0.7                       | 5.6 | 0.7                       | 6.6 |      |
| $t_{PHZ}$ | $t_{PHZ}$ | $\overline{OE}$ | B  | 2                         | 5   | 1.4                       | 9.3 | 1.2                        | 8.1 | 1                         | 6.4 | 0.8                       | 6.2 | ns   |
| $t_{PLZ}$ | $t_{PLZ}$ |                 |    | 2                         | 4.5 | 1.4                       | 9.3 | 1.2                        | 8.1 | 1                         | 6.4 | 0.8                       | 6.2 |      |

## 5.11 Typical Characteristics

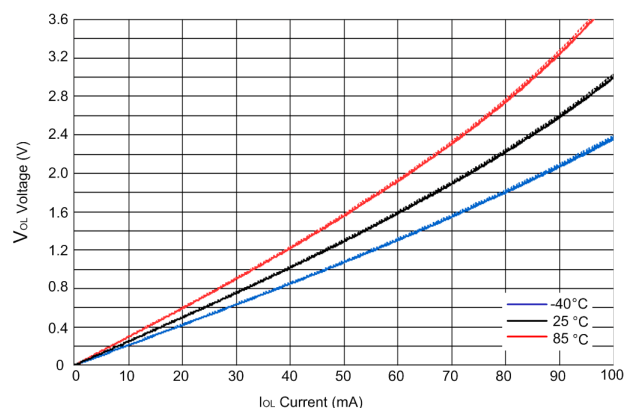


Figure 5-1. Low-Level Output Voltage ( $V_{OL}$ ) vs Low-Level Current ( $I_{OL}$ ) at  $V_{CCA} = V_{CCB} = 3.6V$

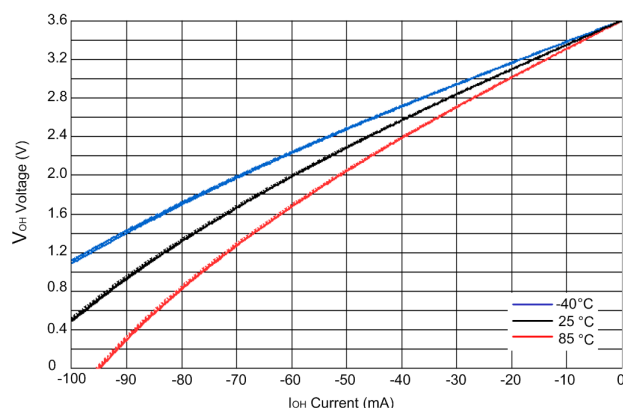


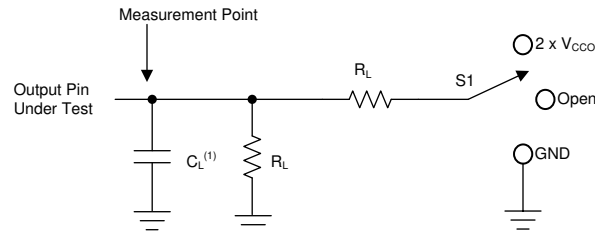
Figure 5-2. High-Level Output Voltage ( $V_{OH}$ ) vs High-Level Current ( $I_{OH}$ ) at  $V_{CCA} = V_{CCB} = 3.6V$

## 6 Parameter Measurement Information

### 6.1 Load Circuit and Voltage Waveforms

Unless otherwise noted, all input pulses are supplied by generators having the following characteristics:

- $f = 10\text{MHz}$
- $Z_O = 50\Omega$
- $\Delta t/\Delta V \leq 1\text{ns/V}$



A.  $C_L$  includes probe and jig capacitance.

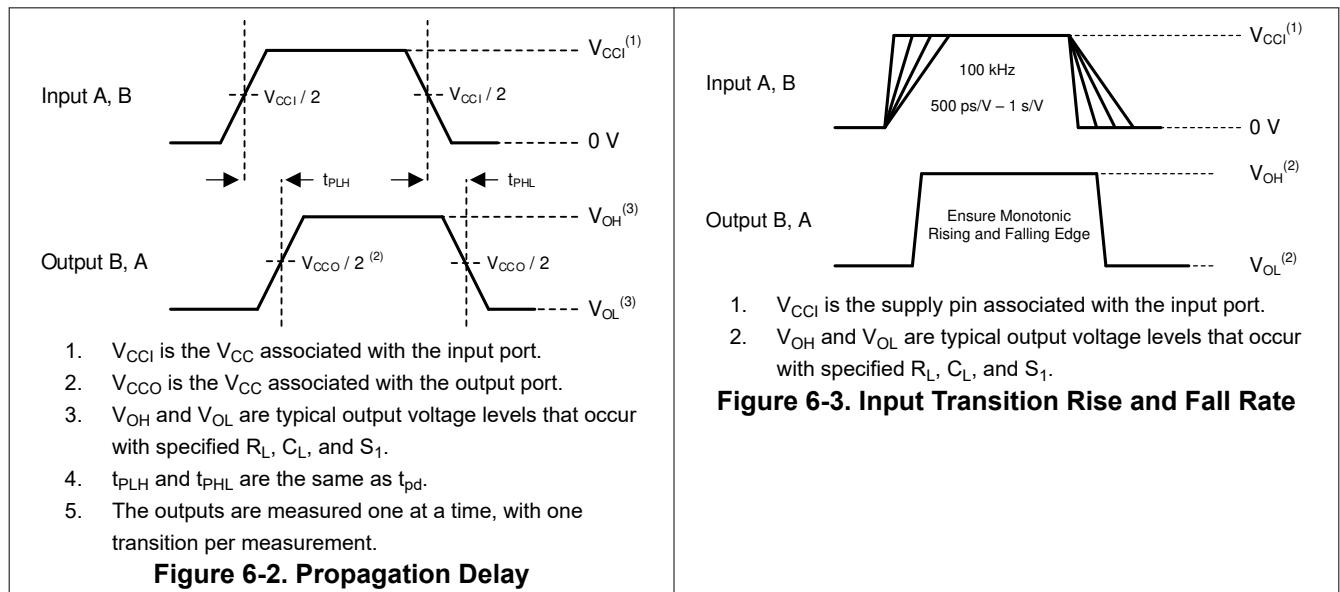
**Figure 6-1. Load Circuit**

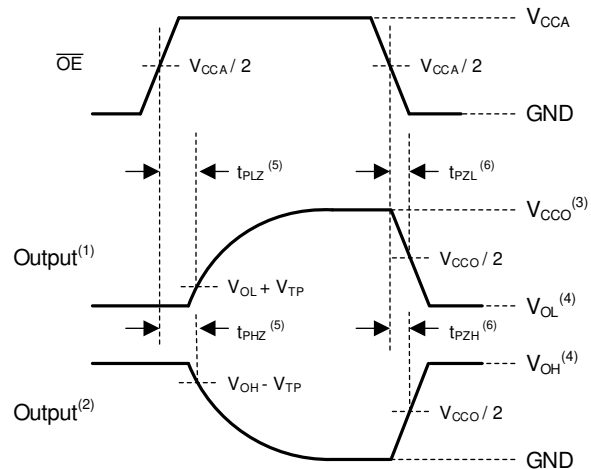
**Table 6-1. Load Circuit Parameters**

| Test Parameter                                  | $S_1$              |
|-------------------------------------------------|--------------------|
| $t_{pd}$ Propagation (delay) time               | Open               |
| $t_{pZL}$ , $t_{pLZ}$ Enable time, disable time | $2 \times V_{CCO}$ |
| $t_{pZH}$ , $t_{pHZ}$ Enable time, disable time | GND                |

**Table 6-2. Load Circuit Conditions**

| $V_{CCO}$                      | $R_L$             | $C_L$         | $V_{TP}$       |
|--------------------------------|-------------------|---------------|----------------|
| $1.2\text{V} \pm 0.1\text{V}$  | $2\text{k}\Omega$ | $15\text{pF}$ | $0.1\text{V}$  |
| $1.5\text{V} \pm 0.1\text{V}$  | $2\text{k}\Omega$ | $15\text{pF}$ | $0.1\text{V}$  |
| $1.8\text{V} \pm 0.15\text{V}$ | $2\text{k}\Omega$ | $15\text{pF}$ | $0.15\text{V}$ |
| $2.5\text{V} \pm 0.2\text{V}$  | $2\text{k}\Omega$ | $15\text{pF}$ | $0.15\text{V}$ |
| $3.3\text{V} \pm 0.3\text{V}$  | $2\text{k}\Omega$ | $15\text{pF}$ | $0.3\text{V}$  |





- A. Output waveform on the condition that input is driven to a valid Logic Low.
- B. Output waveform on the condition that input is driven to a valid Logic High.
- C.  $V_{CCO}$  is the supply pin associated with the output port.
- D.  $V_{OH}$  and  $V_{OL}$  are typical output voltage levels with specified  $R_L$ ,  $C_L$ , and  $S_1$ .
- E.  $t_{PLZ}$  and  $t_{PZH}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .

**Figure 6-4. Enable Time And Disable Time**

## 7 Detailed Description

### 7.1 Overview

The SN74AVC4T774 is a 4-bit, dual-supply, noninverting, bi-directional voltage level translation. Pins An and control pins (DIR1, DIR2, DIR3, DIR4 and  $\overline{OE}$ ) are support by  $V_{CCA}$  and pins Bn are support by  $V_{CCB}$ . The A port is able to accept I/O voltages ranging from 1.1V to 3.6V, while the B port can accept I/O voltages from 1.1V to 3.6V. A high on DIR allows data transmission from An to Bn and a low on DIR allows data transmission from B to A when  $\overline{OE}$  is set to low. When  $\overline{OE}$  is set to high, both An and Bn are in the high-impedance state.

### 7.2 Functional Block Diagram

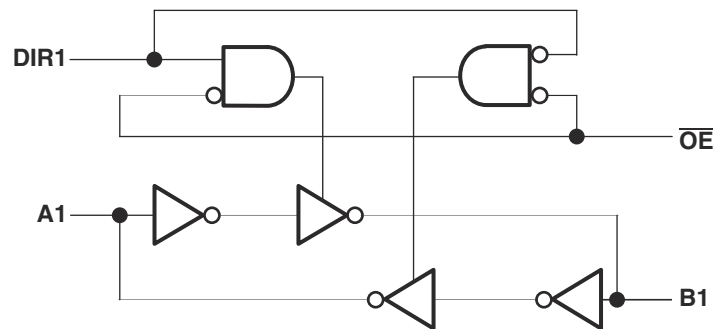


Figure 7-1. Logic Diagram (Positive Logic)

### 7.3 Feature Description

#### 7.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.1V to 3.6V Power-Supply Range

Both  $V_{CCA}$  and  $V_{CCB}$  can be supplied at any voltage between 1.1V and 3.6V making the device suitable for translating between any of the low-voltage nodes (1.2V, 1.8V, 2.5V and 3.3V).

#### 7.3.2 Support High-Speed Translation

SN74AVC4T774 can support high data rate application. The translated signal data rate can be up to 380Mbps when signal is translated from 1.8V to 3.3V.

#### 7.3.3 $I_{off}$ Supports Partial-Power-Down Mode Operation

$I_{off}$  prevents backflow current by disabling I/O output circuits when device is in partial-power-down mode.

### 7.4 Device Functional Modes

Table 7-1. Function Table (Each Bit)

| CONTROL INPUTS  |     | OUTPUT CIRCUITS |         | OPERATION        |
|-----------------|-----|-----------------|---------|------------------|
| $\overline{OE}$ | DIR | A PORT          | B PORT  |                  |
| L               | L   | Enabled         | Hi-Z    | B data to A data |
| L               | H   | Hi-Z            | Enabled | A data to B data |
| H               | X   | Hi-Z            | Hi-Z    | Isolation        |

## 8 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

The SN74AVC4T774 device can be used in level-translation applications for interfacing devices or systems operating at different interface voltages with one another. The device is designed for use in applications where a push-pull driver is connected to the data I/Os. The max data rate can be up to 380Mbps when the device translate signal is from 1.8V to 3.3V.

### 8.2 Typical Application

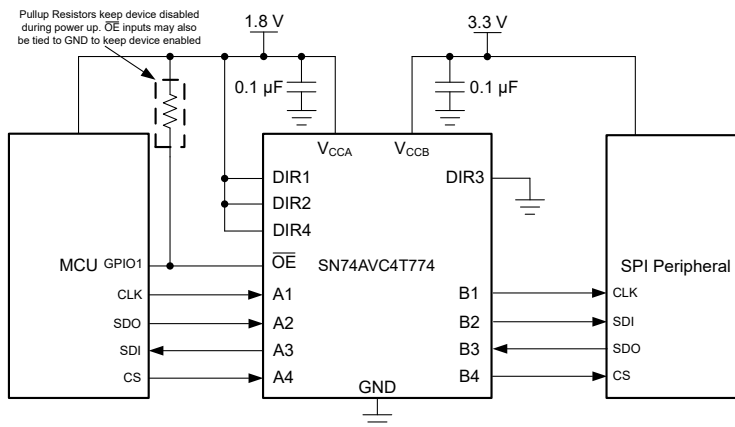


Figure 8-1. Typical Application of the SN74AVC4T774

#### 8.2.1 Design Requirements

For this design example, use the parameters listed in [Table 8-1](#).

Table 8-1. Design Parameters

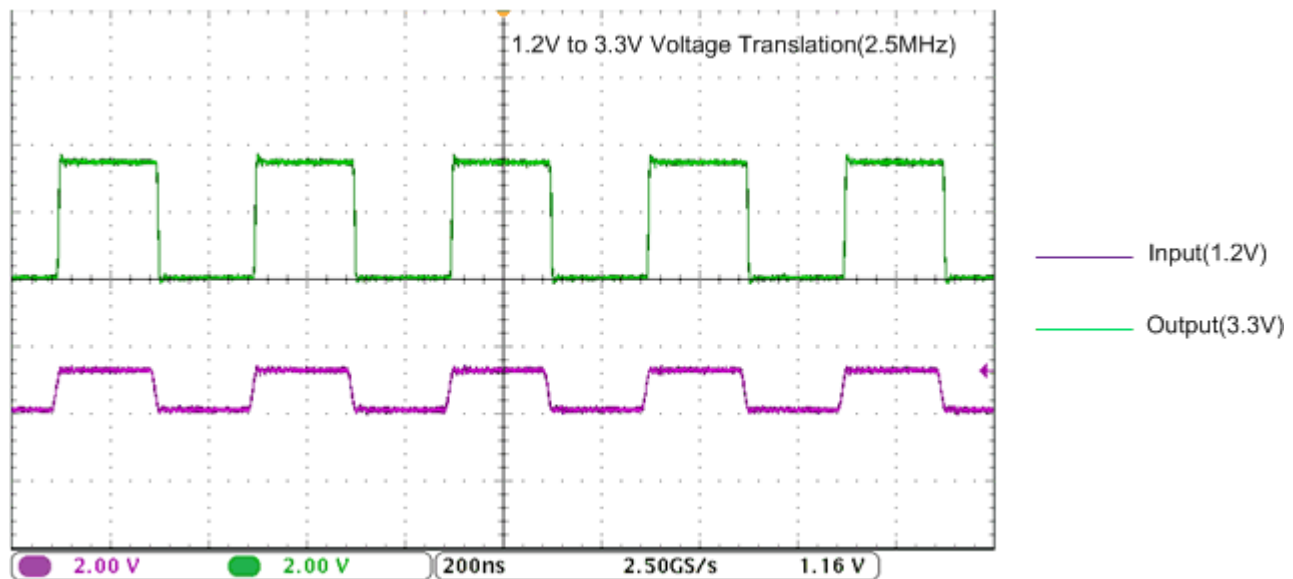
| DESIGN PARAMETERS    | EXAMPLE VALUE |
|----------------------|---------------|
| Input Voltage Range  | 1.1V to 3.6V  |
| Output Voltage Range | 1.1V to 3.6V  |

### 8.2.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the SN74AVC4T774 device to determine the input voltage range. For a valid logic high, the value must exceed the  $V_{IH}$  of the input port. For a valid logic low, the value must be less than the  $V_{IL}$  of the input port.
- Output voltage range
  - Use the supply voltage of the device that the SN74AVC4T774 device is driving to determine the output voltage range.

### 8.2.3 Application Curve



**Figure 8-2. Translation Up (1.2 V to 3.3 V) at 2.5 MHz**

## 8.3 Power Supply Recommendations

The SN74AVC4T774 device uses two separate configurable power-supply rails,  $V_{CCA}$  and  $V_{CCB}$ .  $V_{CCA}$  accepts any supply voltage from 1.1V to 3.6V and  $V_{CCB}$  accepts any supply voltage from 1.1V to 3.6V. The A port and B port are designed to track  $V_{CCA}$  and  $V_{CCB}$  respectively allowing for low-voltage, bi-directional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V and 3.3V voltage nodes.

The output-enable  $\overline{OE}$  input circuit is designed so that it is supplied by  $V_{CCA}$  and when the  $\overline{OE}$  input is high, all outputs are placed in the high-impedance state. To ensure the high-impedance state of the outputs during power-up or power-down, the  $\overline{OE}$  input pin must be tied to  $V_{CCA}$  through a pullup resistor and must not be enabled until  $V_{CCA}$  and  $V_{CCB}$  are fully ramped and stable. The minimum value of the pullup resistor to  $V_{CCA}$  is determined by the current-sinking capability of the driver.

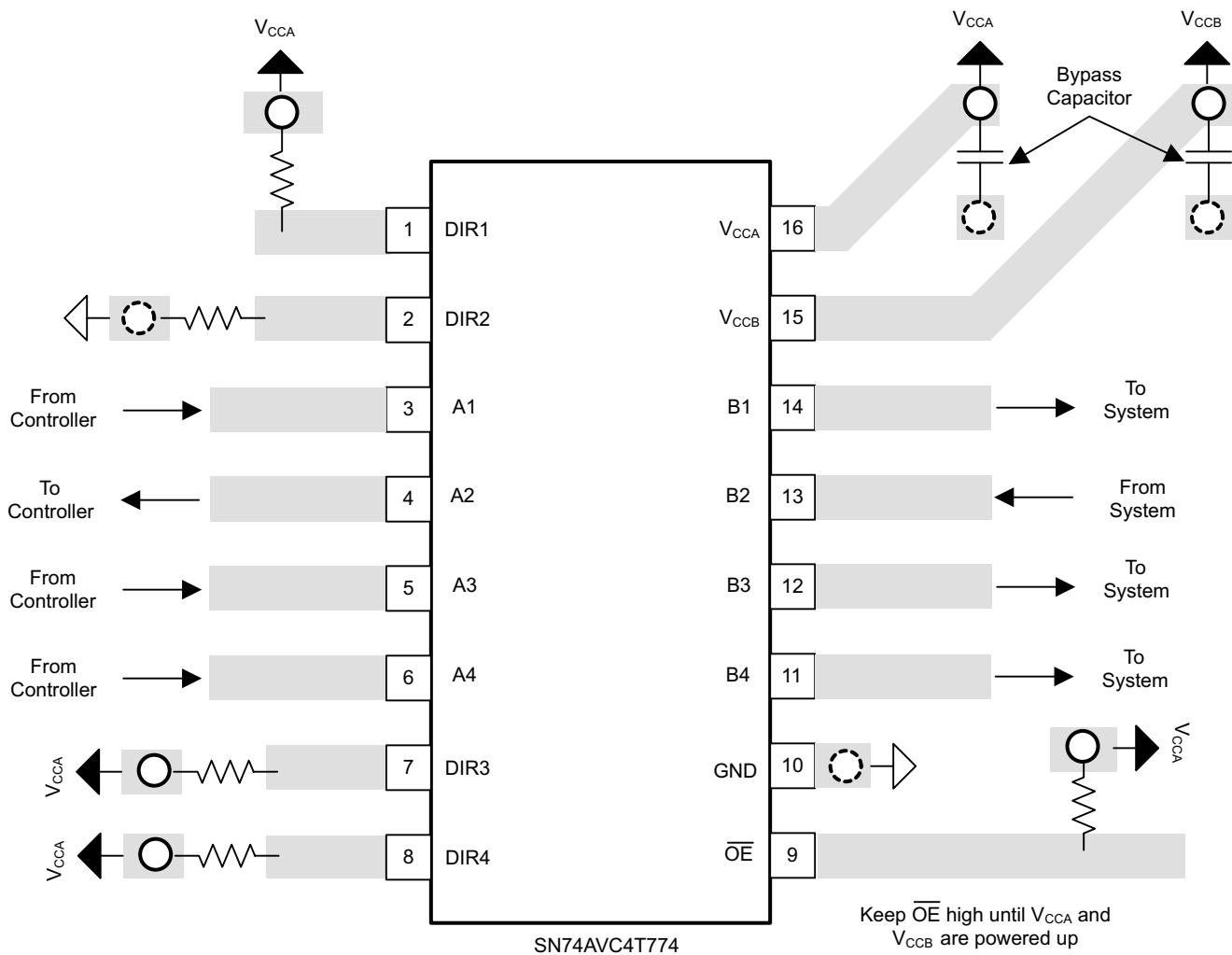
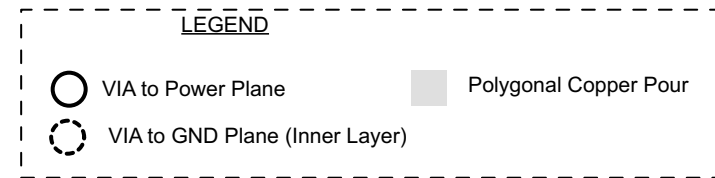
## 8.4 Layout

### 8.4.1 Layout Guidelines

For reliability of the device, following common printed-circuit board layout guidelines are recommended:

- Bypass capacitors should be used on power supplies.
- Short trace lengths should be used to avoid excessive loading.
- Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements

### 8.4.2 Layout Example



**Figure 8-3. PCB Layout Example**

## 9 Device and Documentation Support

### 9.1 Documentation Support

#### 9.1.1 Related Documentation

For related documentation see the following:

- Texas Instruments, [16-Bit Widebus Logic Families in 56-Ball, 0.65-mm Pitch Very Thin Fine-Pitch BGA application report](#)
- Texas Instruments, [AVC Logic Family Technology and Applications application report](#)
- Texas Instruments, [AVC Advanced Very-Low-Voltage CMOS Logic Data Book, March 2000 data book](#)
- Texas Instruments, [Dynamic Output Control \(DOC\) Circuitry Technology And Applications \(Rev. B\) application report](#)
- Texas Instruments, [Introduction to Logic application report](#)
- Texas Instruments, [LCD Module Interface Application Clip brochure](#)
- Texas Instruments, [Logic Cross-Reference application note](#)
- Texas Instruments, [Logic Guide marketing selection guide](#)
- Texas Instruments, [LOGIC Pocket Data Book data book](#)
- Texas Instruments, [Selecting the Right Level Translation Solution application report](#)
- Texas Instruments, [Semiconductor Packing Material Electrostatic Discharge \(ESD\) Protection application report](#)
- Texas Instruments, [Solving CMOS Transition Rate Issues Using Schmitt Trigger Solution white paper](#)
- Texas Instruments, [Standard Linear & Logic for PCs, Servers & Motherboards brochure](#)
- Texas Instruments, [TI Tablet Solutions solution guide](#)
- Texas Instruments, [Understanding and Interpreting Standard-Logic Data Sheets application report](#)
- Texas Instruments, [Voltage Translation Between 3.3-V, 2.5-V, 1.8-V, and 1.5-V Logic Standards application report](#)

### 9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 9.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.  
All trademarks are the property of their respective owners.

### 9.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 9.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Changes from Revision H (May 2024) to Revision I (February 2025)</b> | <b>Page</b> |
|-------------------------------------------------------------------------|-------------|
|-------------------------------------------------------------------------|-------------|

- |                                               |                   |
|-----------------------------------------------|-------------------|
| • Updated RGY and PW thermal information..... | <a href="#">7</a> |
|-----------------------------------------------|-------------------|

| <b>Changes from Revision G (May 2021) to Revision H (March 2024)</b> | <b>Page</b> |
|----------------------------------------------------------------------|-------------|
|----------------------------------------------------------------------|-------------|

- |                                                        |                   |
|--------------------------------------------------------|-------------------|
| • Added the BQB and DYY packages to the datasheet..... | <a href="#">1</a> |
|--------------------------------------------------------|-------------------|

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins            | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------------|---------------|----------------------|---------------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">74AVC4T774RSVR-NT</a> | Active        | Production           | UQFN (RSV)   16           | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | ZVK                 |
| <a href="#">SN74AVC4T774BQBR</a>  | Active        | Production           | WQFN (BQB)   16           | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | WT774               |
| SN74AVC4T774DYYR                  | Active        | Production           | SOT-23-THIN<br>(DYY)   16 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | WT774               |
| <a href="#">SN74AVC4T774PW</a>    | Active        | Production           | TSSOP (PW)   16           | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | WT774               |
| <a href="#">SN74AVC4T774PWR</a>   | Active        | Production           | TSSOP (PW)   16           | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | WT774               |
| <a href="#">SN74AVC4T774RGYR</a>  | Active        | Production           | VQFN (RGY)   16           | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | WT774               |
| <a href="#">SN74AVC4T774RSVR</a>  | Active        | Production           | UQFN (RSV)   16           | 3000   LARGE T&R      | Yes         | NIPDAU   NIPDAU                      | Level-1-260C-UNLIM                | -40 to 85    | ZVK                 |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN74AVC4T774 :**

- Automotive : [SN74AVC4T774-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| 74AVC4T774RSVR-NT | UQFN         | RSV             | 16   | 3000 | 180.0              | 9.5                | 2.1     | 2.9     | 0.75    | 4.0     | 8.0    | Q1            |
| SN74AVC4T774BQBR  | WQFN         | BQB             | 16   | 3000 | 180.0              | 12.4               | 2.8     | 3.8     | 1.2     | 4.0     | 12.0   | Q1            |
| SN74AVC4T774DYYR  | SOT-23-THIN  | DYY             | 16   | 3000 | 330.0              | 12.4               | 4.8     | 3.6     | 1.6     | 8.0     | 12.0   | Q3            |
| SN74AVC4T774PWR   | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74AVC4T774RGYR  | VQFN         | RGY             | 16   | 3000 | 330.0              | 12.4               | 3.8     | 4.3     | 1.5     | 8.0     | 12.0   | Q1            |
| SN74AVC4T774RSVR  | UQFN         | RSV             | 16   | 3000 | 178.0              | 13.5               | 2.1     | 2.9     | 0.75    | 4.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74AVC4T774RSVR-NT | UQFN         | RSV             | 16   | 3000 | 189.0       | 185.0      | 36.0        |
| SN74AVC4T774BQBR  | WQFN         | BQB             | 16   | 3000 | 210.0       | 185.0      | 35.0        |
| SN74AVC4T774DYR   | SOT-23-THIN  | DYY             | 16   | 3000 | 336.6       | 336.6      | 31.8        |
| SN74AVC4T774PWR   | TSSOP        | PW              | 16   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74AVC4T774RGYR  | VQFN         | RGY             | 16   | 3000 | 356.0       | 356.0      | 35.0        |
| SN74AVC4T774RSVR  | UQFN         | RSV             | 16   | 3000 | 189.0       | 185.0      | 36.0        |

## TUBE



\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74AVC4T774PW | PW           | TSSOP        | 16   | 90  | 530    | 10.2   | 3600   | 3.5    |



4220204/A 02/2017

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

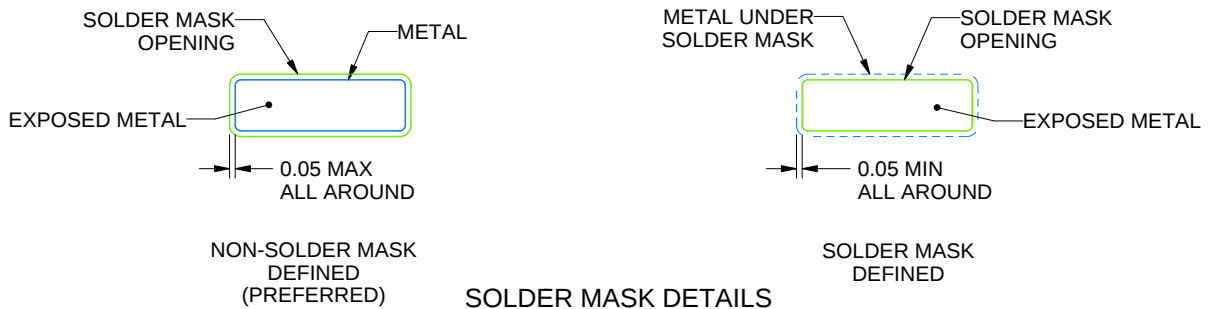
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220204/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

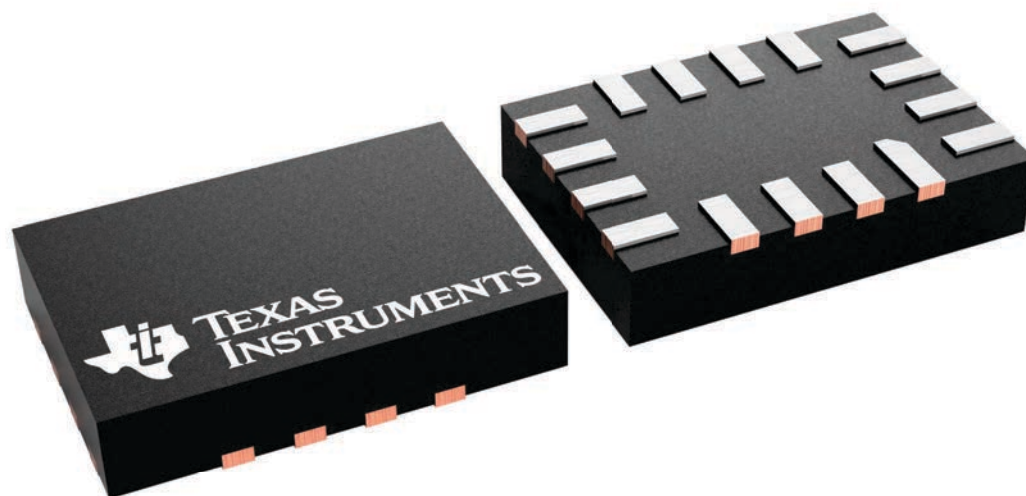
**RSV 16**

**UQFN - 0.55 mm max height**

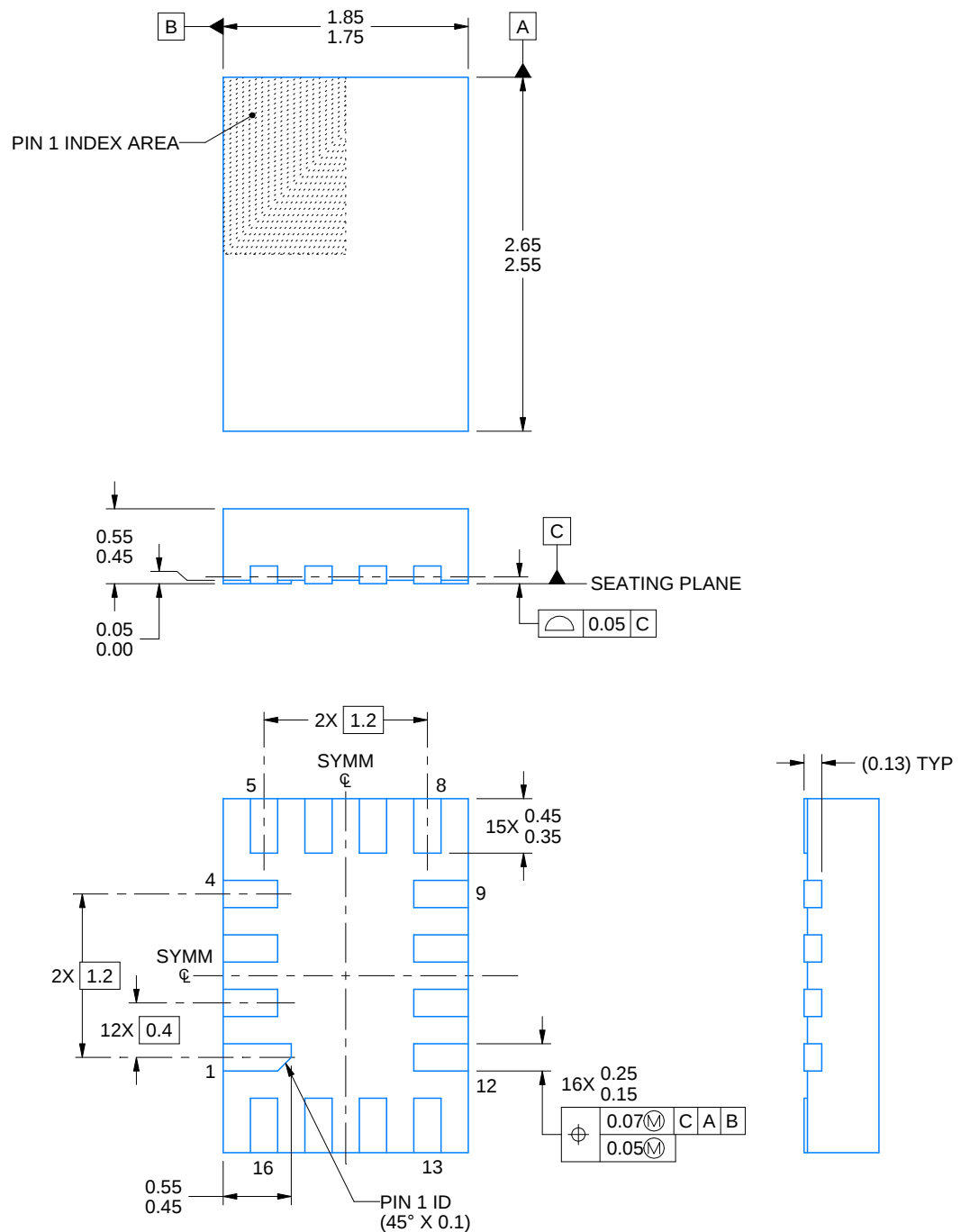
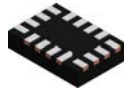
1.8 x 2.6, 0.4 mm pitch

ULTRA THIN QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4231225/A



4220314/C 02/2020

## NOTES:

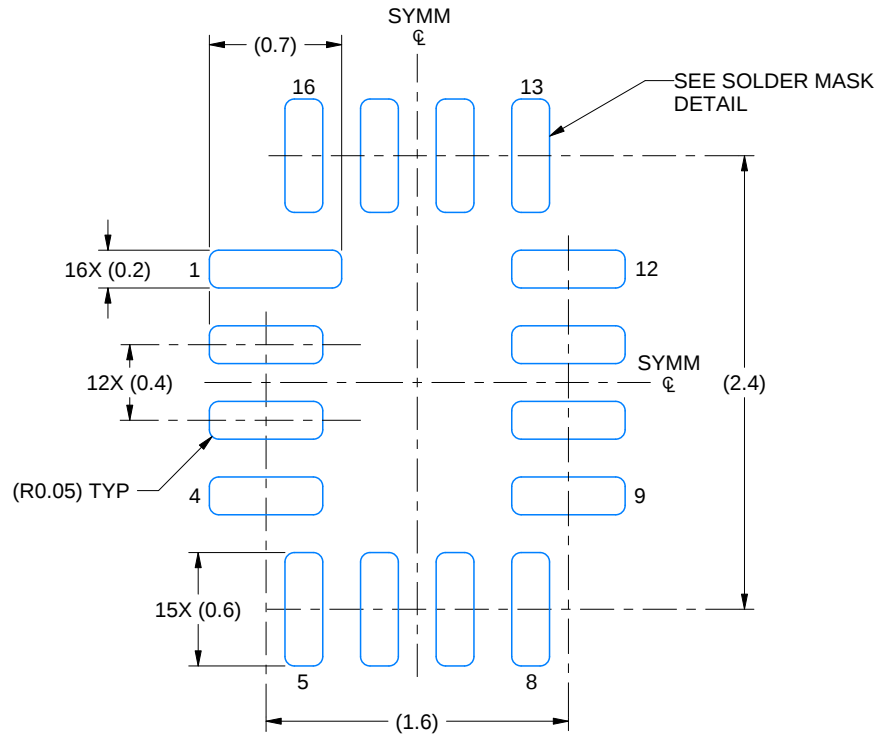
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

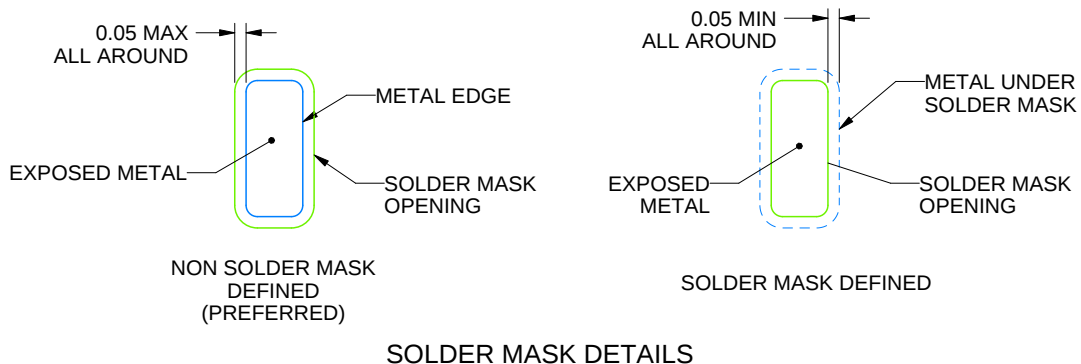
RSV0016A

UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 25X



4220314/C 02/2020

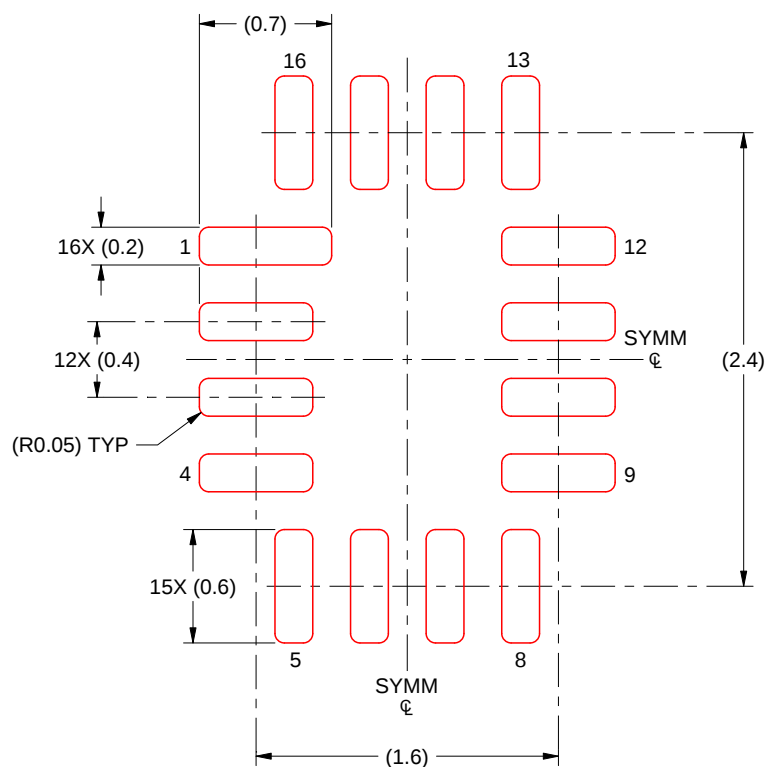
NOTES: (continued)

3. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

**RSV0016A**

## UQFN - 0.55 mm max height

ULTRA THIN QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 MM THICK STENCIL  
SCALE: 25X

4220314/C 02/2020

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## GENERIC PACKAGE VIEW

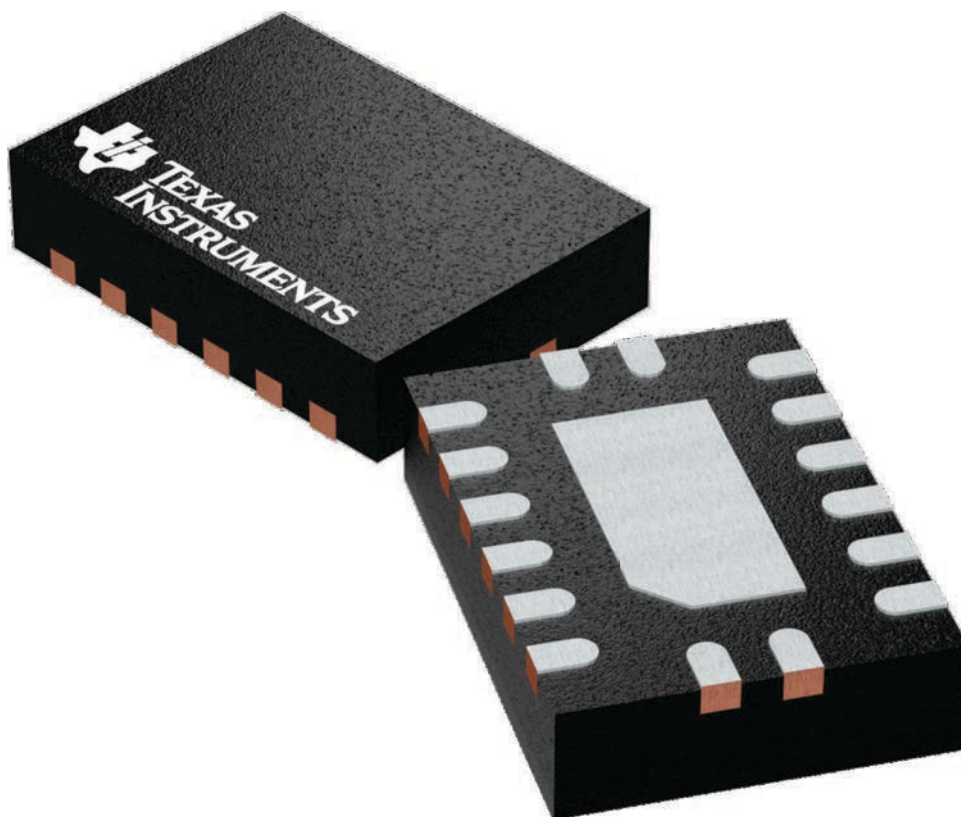
**BQB 16**

**WQFN - 0.8 mm max height**

2.5 x 3.5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

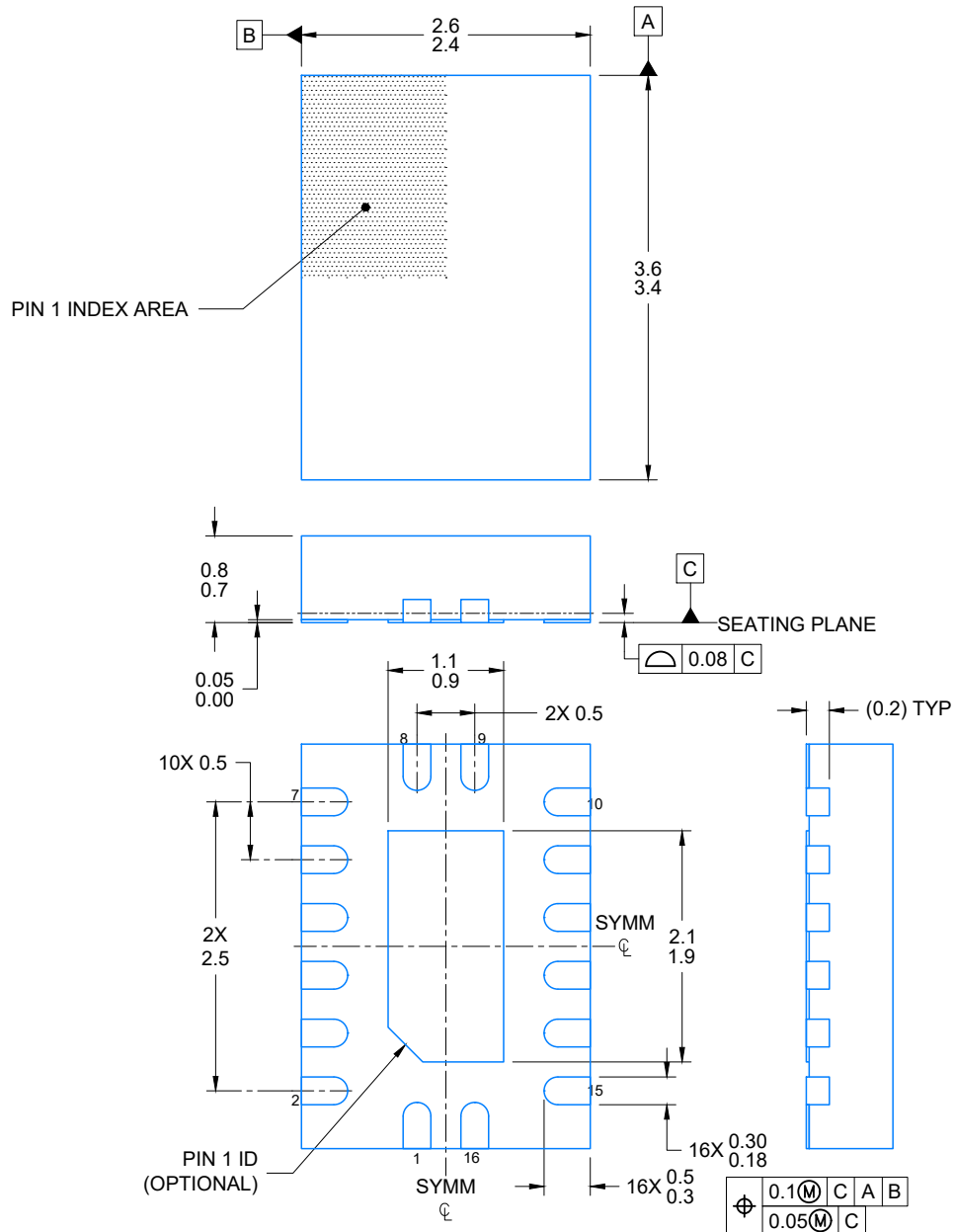


4226161/A

## PACKAGE OUTLINE

**WQFN - 0.8 mm max height**

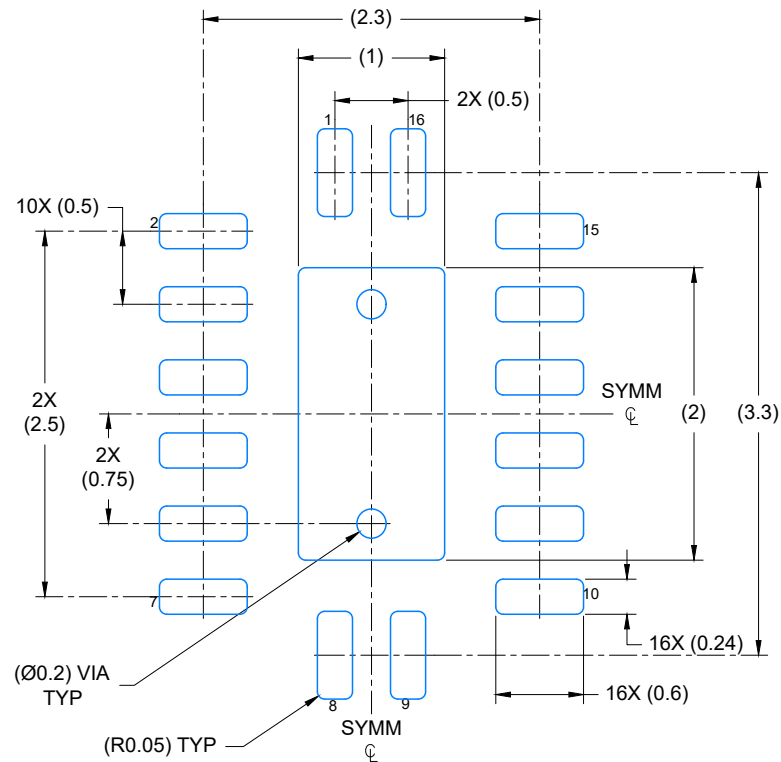
PLASTIC QUAD FLAT PACK-NO LEAD



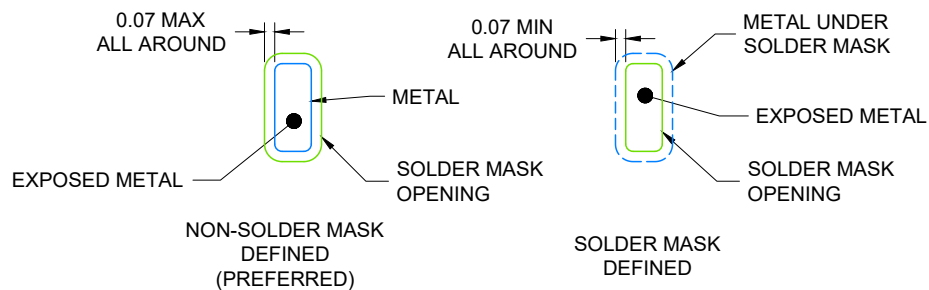
4224640/A 11/2018

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



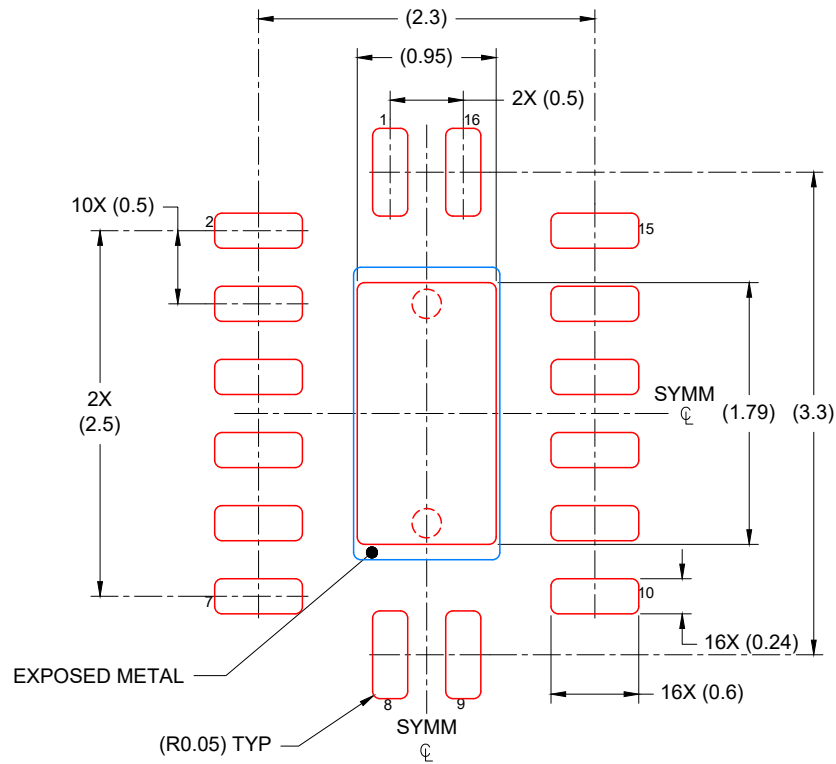
LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X



4224640/A 11/2018

## NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slue271](http://www.ti.com/lit/slue271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



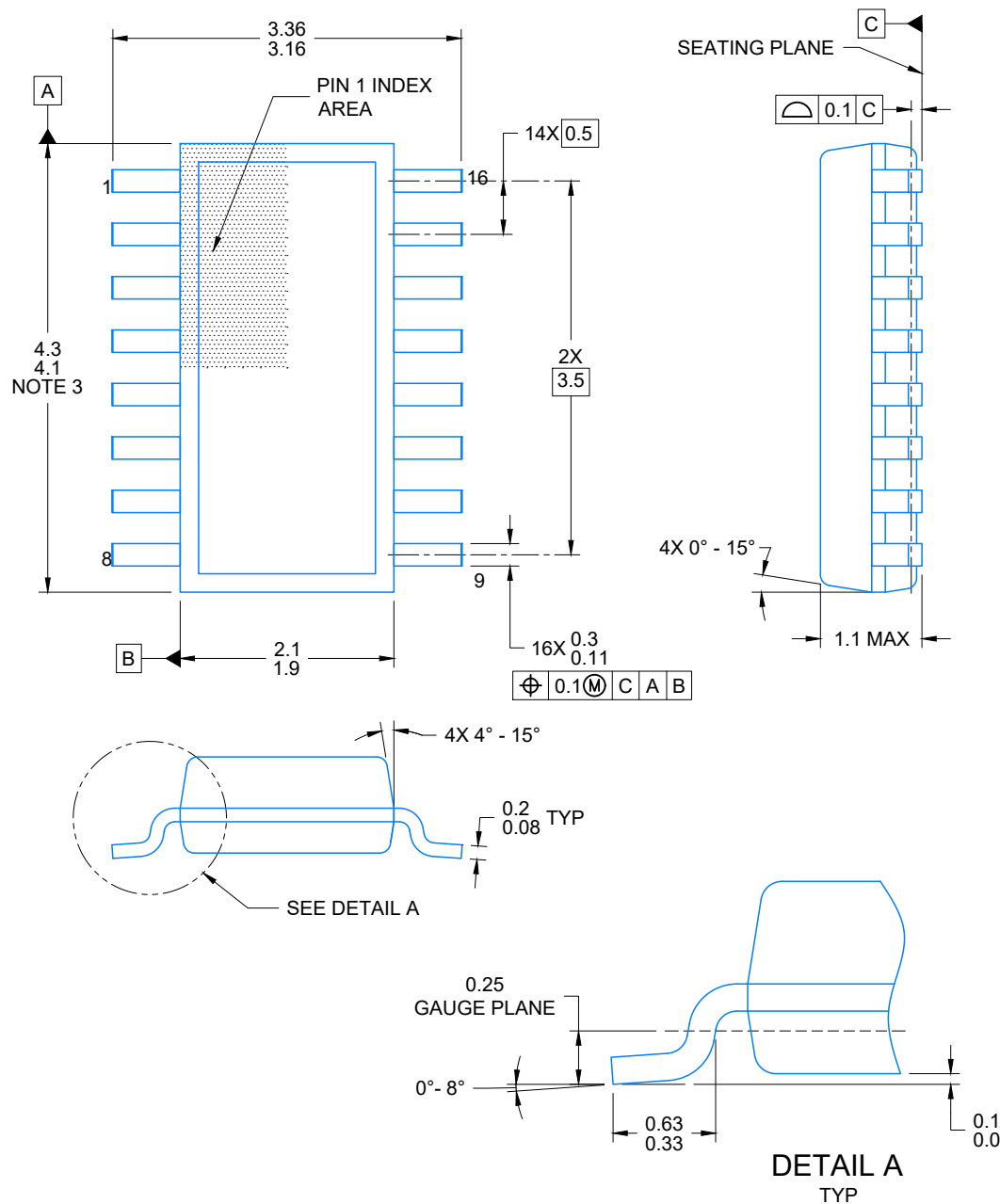
SOLDER PASTE EXAMPLE  
 BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
 85% PRINTED COVERAGE BY AREA  
 SCALE: 20X

4224640/A 11/2018

NOTES: (continued)

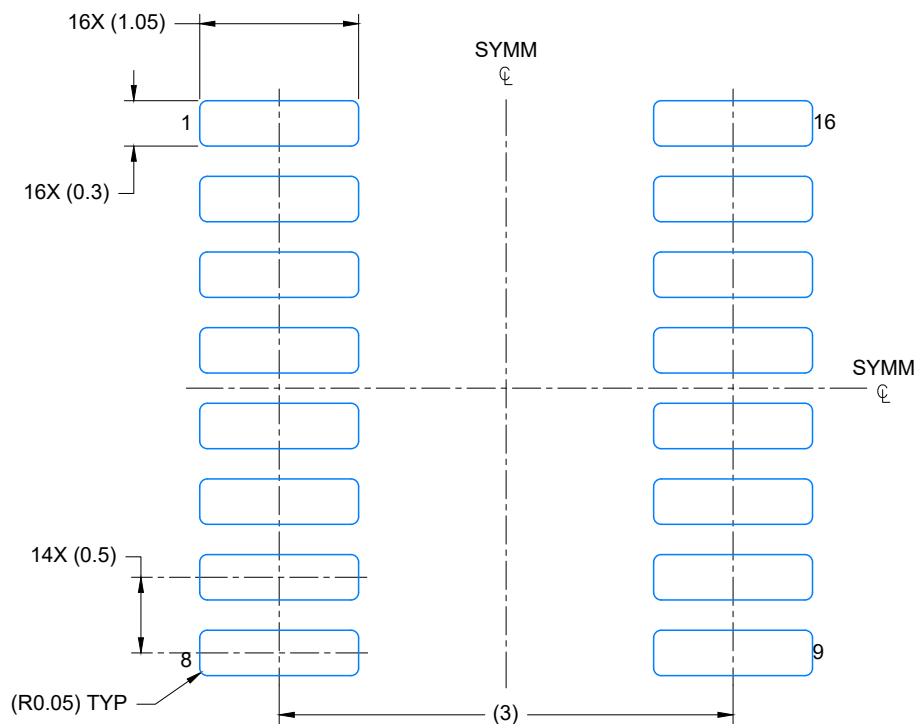
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



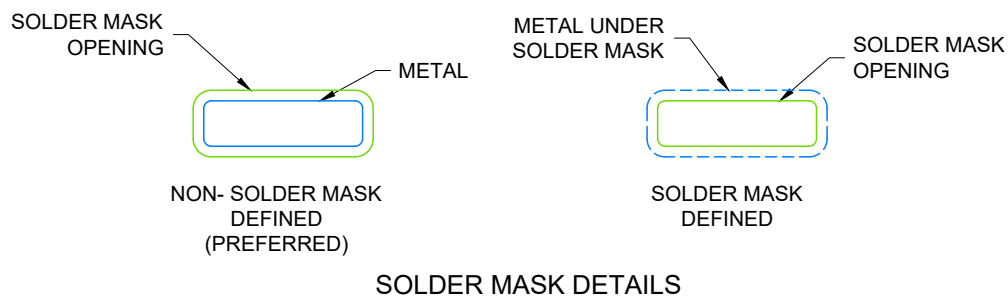
4224642/D 07/2024

## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
5. Reference JEDEC Registration MO-345, Variation AA



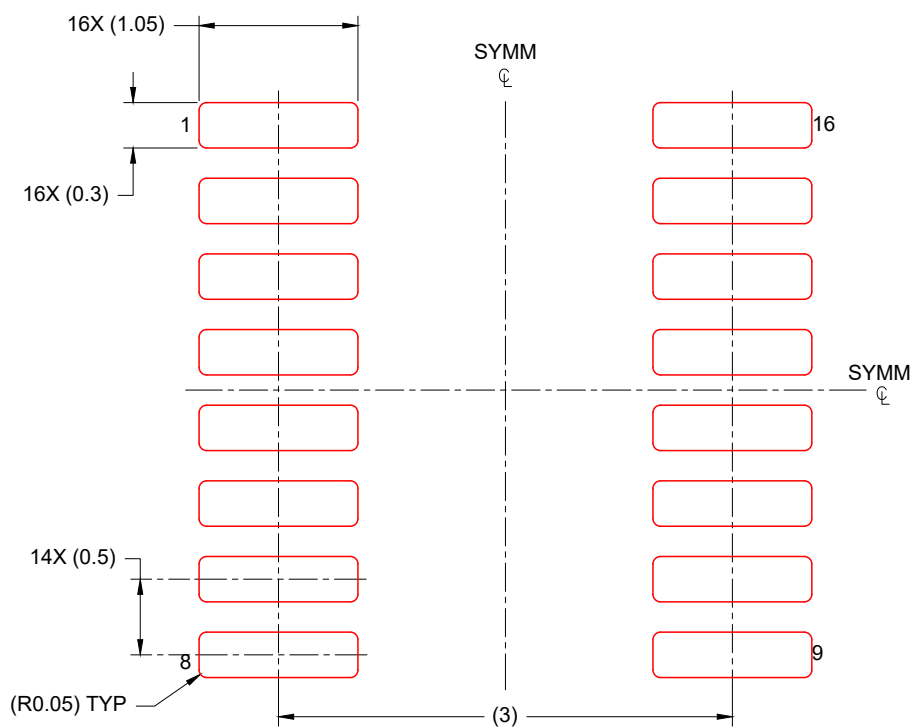
LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X



4224642/D 07/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 20X

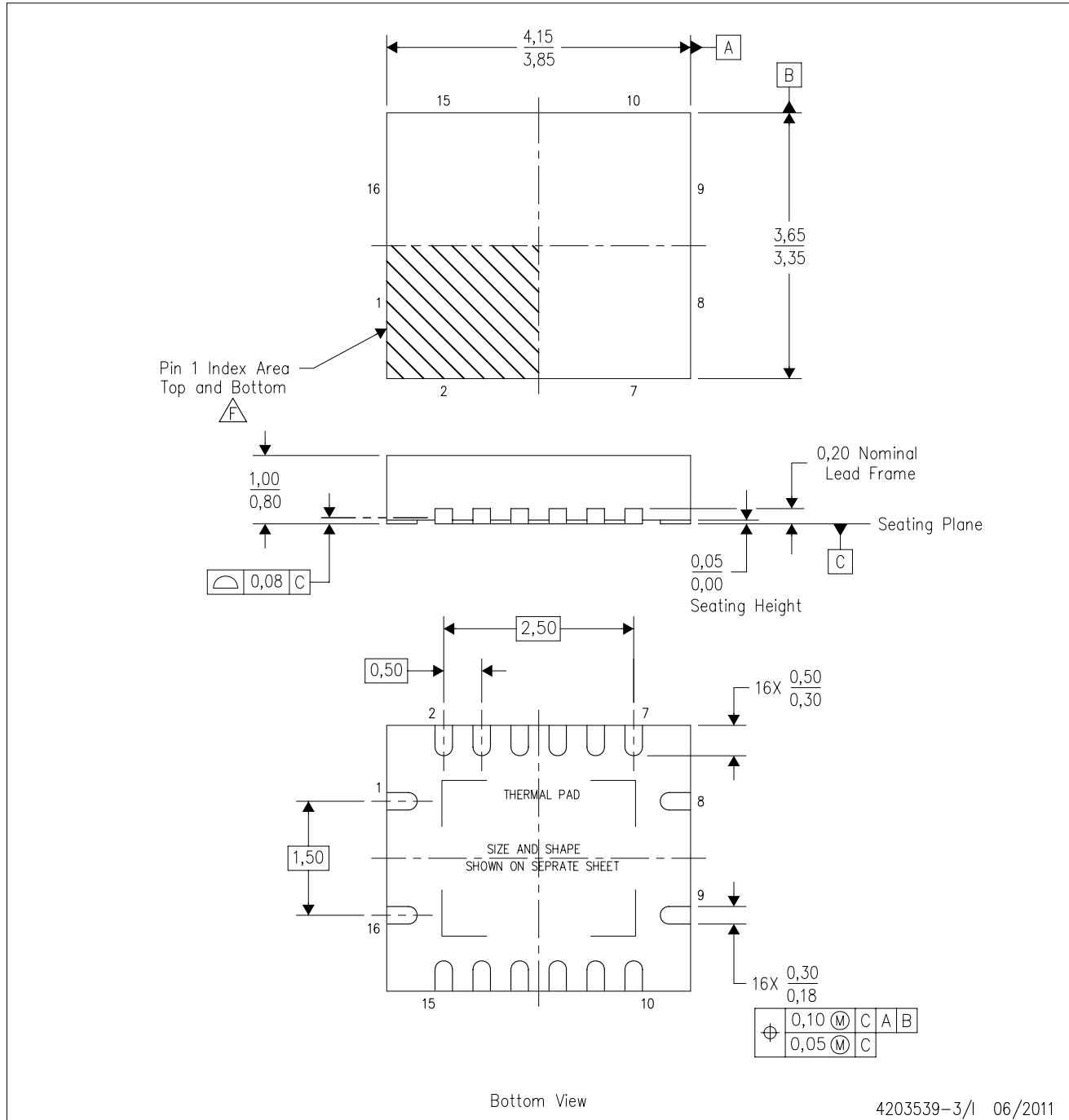
4224642/D 07/2024

## NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

RGY (R-PVQFN-N16)

PLASTIC QUAD FLATPACK NO-LEAD



4203539-3/I 06/2011

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - This drawing is subject to change without notice.
  - QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance.
  - See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
  - Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
  - Package complies to JEDEC MO-241 variation BA.

RGY (R-PVQFN-N16)

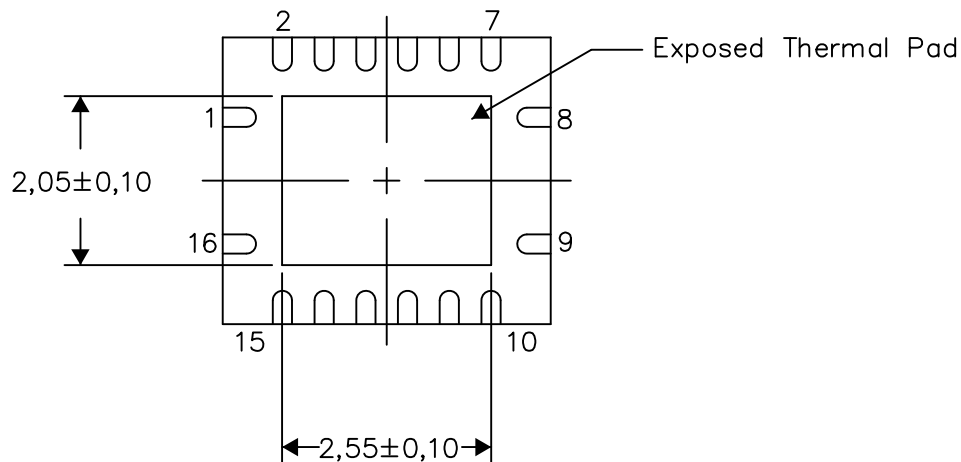
PLASTIC QUAD FLATPACK NO-LEAD

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

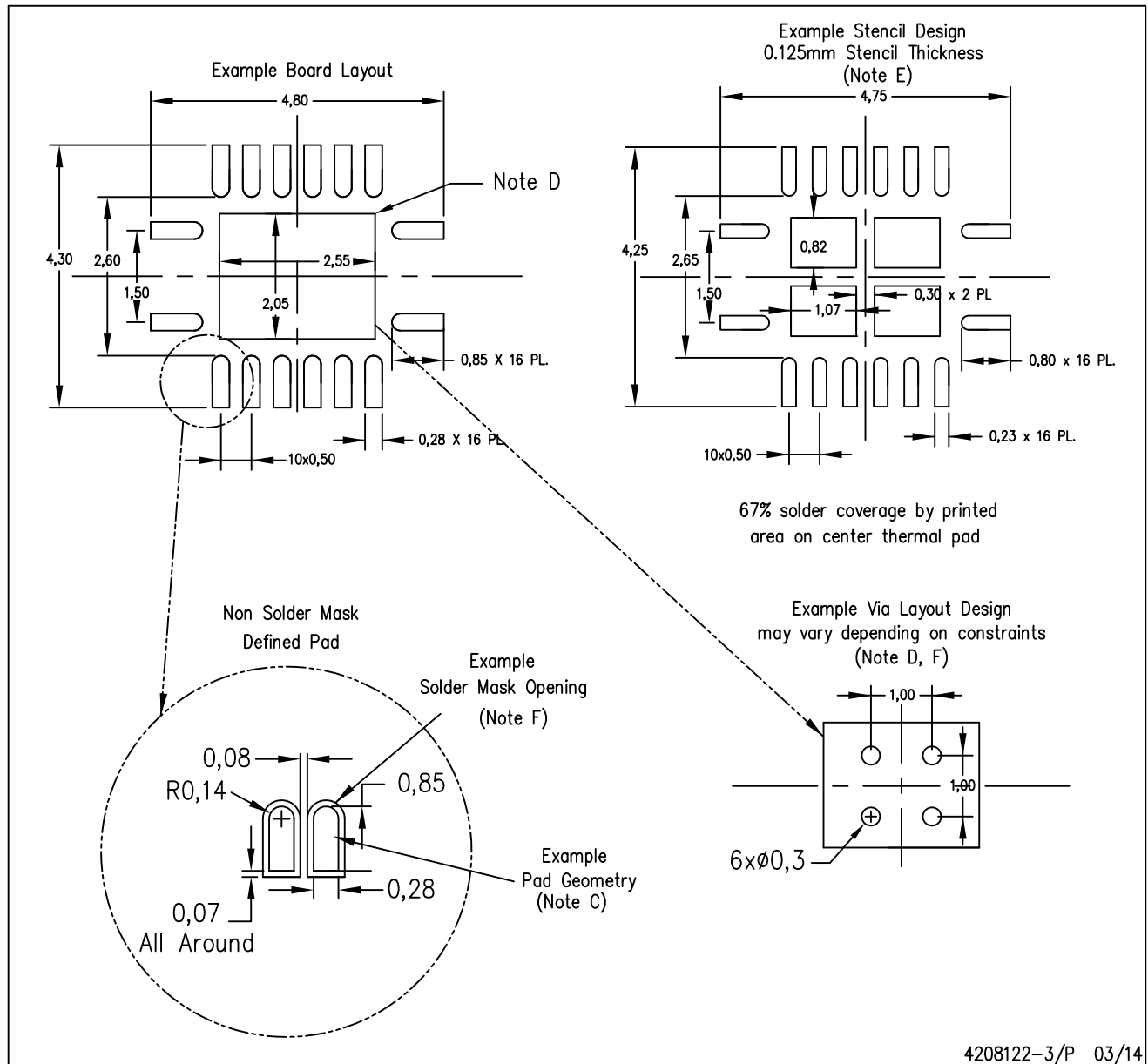
Exposed Thermal Pad Dimensions

4206353-3/P 03/14

NOTE: All linear dimensions are in millimeters

RGY (R-PVQFN-N16)

PLASTIC QUAD FLATPACK NO-LEAD



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.

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